

ANNEX 1

Detalls tècnics TS-TPC-7990

CPU	
Architecture	Arm
Part Number	i.MX6
Vendor	NXP
CPU Speed	1.1 GHz
Floating Point Unit	Yes
CPU Cores (Max)	4x

CORE SPECS	
Base Memory Capacity	1 GB

STORAGE	
Base Flash Capacity	4 GB (2 GB SLC or 4 GB MLC)
Flash Type	eMMC
microSD Card Socket	1x
SATA Ports	1x (mSATA (Only with Quad Core))

OTHER	
Battery-Backed Real Time Clock	1x
Graphics Processing Unit	Yes

GENERAL I/O	
General-Purpose Input/Output (GPIO) Pins	9x

SERIAL INTERFACES	
RS-232 Ports	4x
RS-485 Ports	3x
SPI Ports	1x
I2C Ports	1x

PERIPHERAL INTERFACES	
USB Host Ports	2x
USB Device Ports	1x
mini PCI Express Bus	1x

INDUSTRIAL PROTOCOLS	
CAN Ports	2x

NETWORKING	
Gigabit Ethernet Ports	1x
10/100 Ethernet Ports	1x
Power-over-Ethernet	Yes

PHYSICAL

Operating Supply Voltage	5 VDC to 36 VDC (5 VDC or 8 - 36 VDC)
Fanless Temperature Range	-20 ° to 70 °C

GRAPHICS / HMI

Screen Diagonal Size	7"
Touchscreen	Yes
Screen Resolution	1024x600 (Resistive screen: 800x600)
Speaker	Yes
Touchscreen Type	Capacitive

RADIO COMMS

Bluetooth	Yes
WiFi Radio / Wireless LAN	Yes

SOLUTIONS

TS-SILO Power Reserve (Super Capacitors)	Yes
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SOLUTIONS

TS-SILO Power Reserve (Super Capacitors)	Yes
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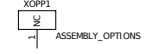
SOFTWARE

Linux Kernel Version	4.1
Debian Linux	Jessie (8.11)
Android OS	7.1.1 Nougat
Yocto Linux	2.2 Morty

SENSORS

Accelerometer/Gyro	Yes
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TS-7990 Standard Options



Option 1	TS-TPC-7990-SMN2E	800x480 800nit Resistive Touch display, Solo 800MHz i.MX6 CPU, 1G RAM, 4G eMMC, Extended Temp
	TS-TPC-7990-SMN3E	1024x600 800nit Capacitive Touch display, Solo 800MHz i.MX6 CPU, 1G RAM, 4G eMMC, Extended Temp
Option 3	TS-TPC-7990-QMW2E	800x480 800nit Resistive Touch display, Quad 1GHz CPU, 1G RAM, 4G eMMC, NimbeLink Socket, WiFi, Accelerometer, Extended Temp
	TS-TPC-7990-QMW3E	1024x600 800nit Capacitive Touch display, Quad 1GHz CPU, 1G RAM, 4G eMMC, NimbeLink Socket, WiFi, Accelerometer, Extended

LXD LCD Option

7", 1024x600, PCAP Touch, 800nit

Included on ALL Standard Options

Add: CN1, CN5, P4

OKAYA LCD Option

7", 800x480, Resistive Touch, 800nit

Included on ALL Standard Options

Add: CN11, CN4, P3

PCIe socket Option:

Included on ALL Standard Options

Add: U50, J3, U45, MT5, MT6

SIM socket Option:

NOT Included on any Standard Options

Add: CN13

Heat Sink for CPU

TSPN: HS-50x53x13

Accelerometer Option:

Included Only on Qxxxx Standard Option

Add: U21

NimbeLink Socket Option:

Included Only on Qxxxx Standard Option

Add: CN6 & CN6A

WiFi/Bluetooth Option

w/ Chip Antenna

U.FL available on request

Included Only on Qxxxx Standard Option

Add: K2 (Chip antenna)
(alternate: U.FL antenna connector)

Choke Option

Input power filter feature

NOT Included on any Standard Options

ADD: CH1 - Remove FB46, FB44

MT LCD Option

NOT Included on any Standard Options

7", 800x480, Resistive Touch, 320nit

Remove: P4, CN1, CN5, CN11, CN4, and P3

Add: U59, CN8 and CN9

Technologic Systems	Date	June 1, 2017
Title: TS-7990		
Rev: C	Designer	Sheet 1 of 30

TS-7990 Rev.B --> Rev.C Changes

Correct several footprints

Correct Capacitive Touch Sense solution

Mini-PCIe socket uses DIO for reset (can not use CPU_RESET#)

Added Optional SIM Socket (CN13)

Change WiFi to use SPI (SDIO does not work)

eMMC 3.3V has power input that can be switched

BOM scrubbing for REACH/RoHS2 Compliance

Added RESET# to CN6

Moved TOUCH_RESET to a CPU DIO pin

All 4 iMX6 UARTs MUXed thru FPGA

FPGA has some MAX3100 UARTs

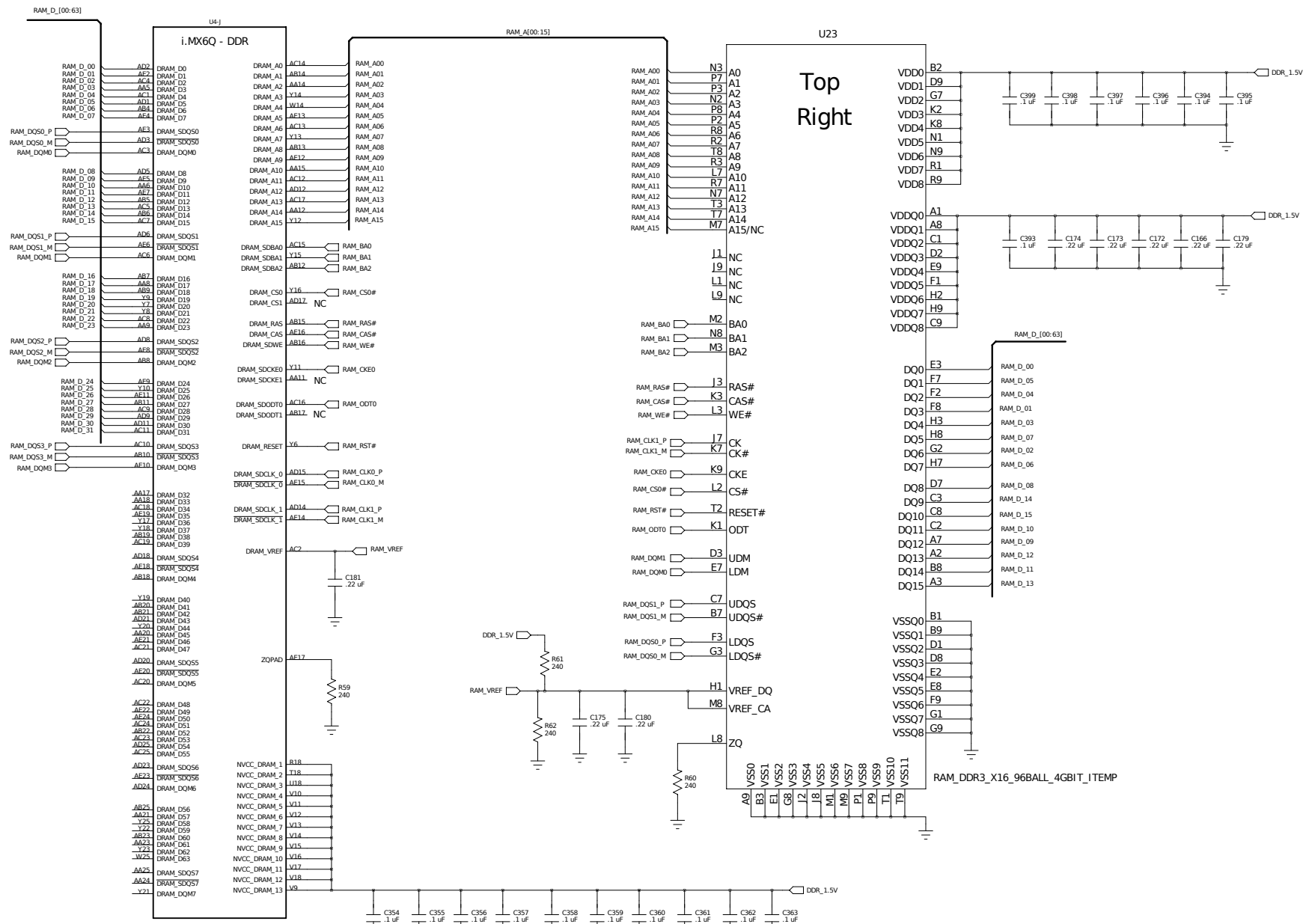
Features that require UART:

3 RS-232 Ports

3 RS-485 Ports

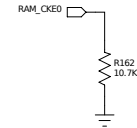
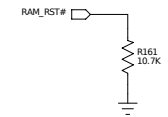
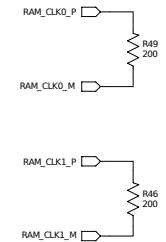
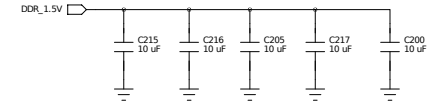
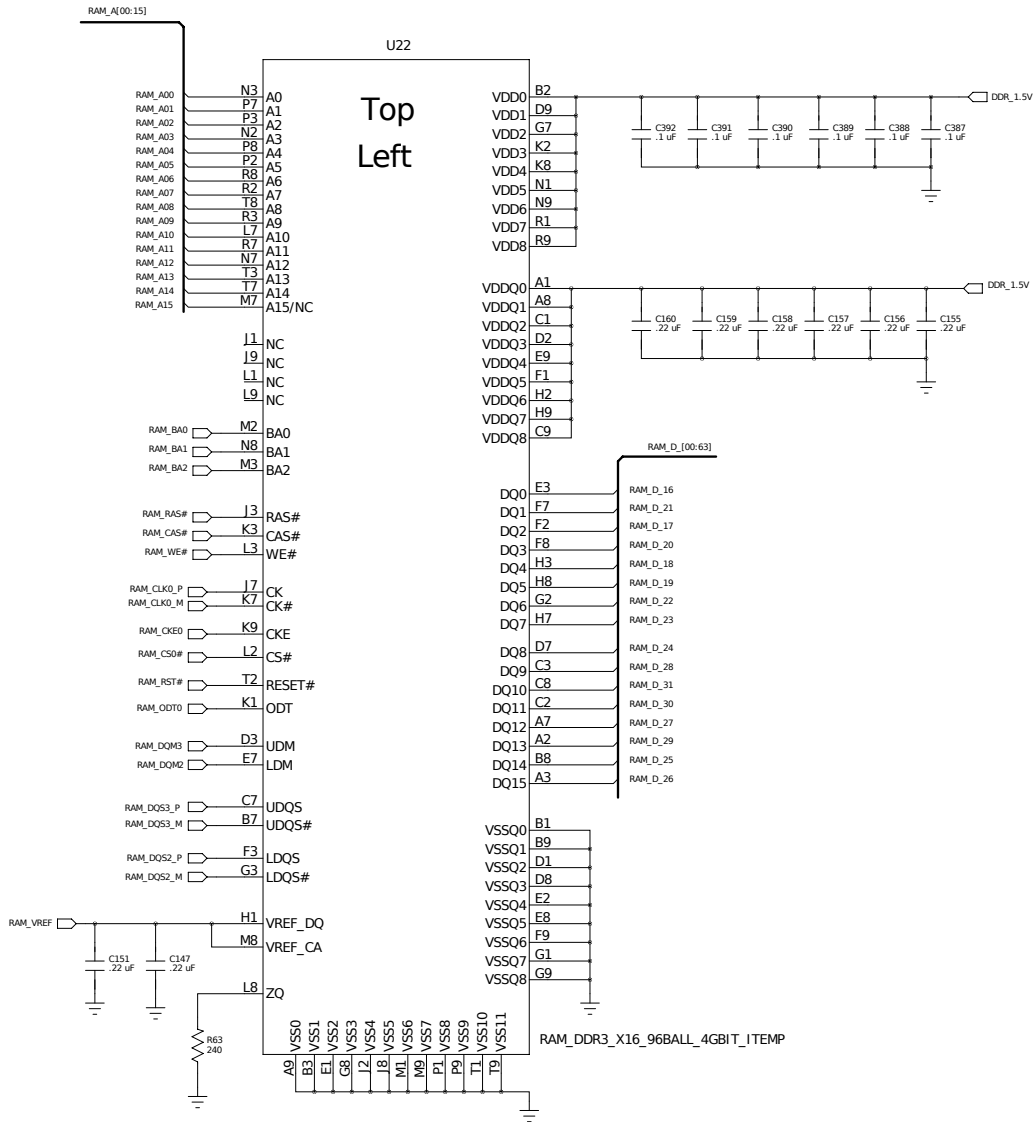
1 UART for NimbeLink

1 UART for BlueTooth

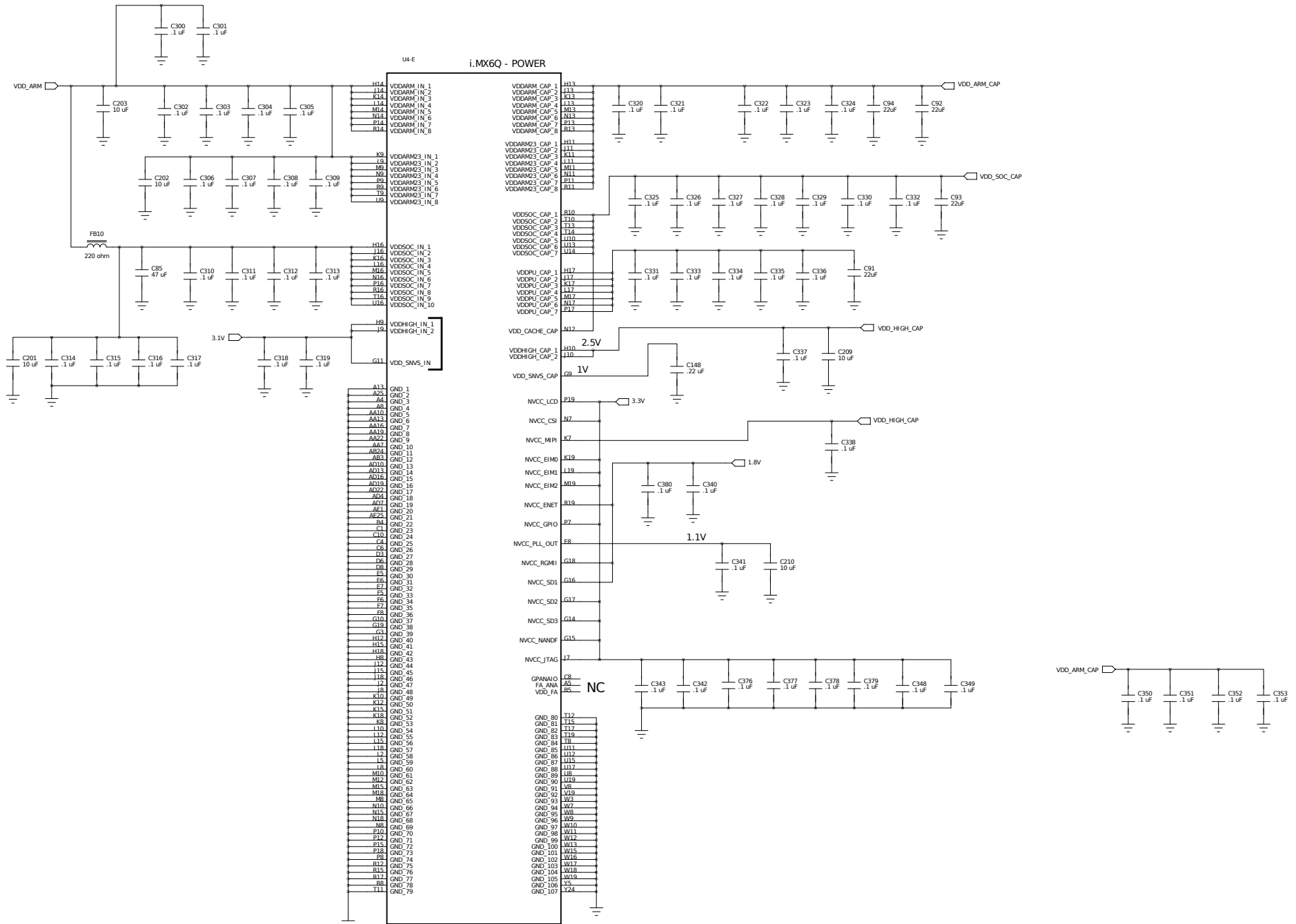


MX6_SINGLE_CORE_BGA24
 *Option 1 = NXP MCI M6G5/CVMB8AB (Single Core, 800MHz, 1-Temp)
 Option 3 = NXP MCI M6G5EYML0AC (Quad Core, 1GHz, E-Temp)

RAM Data bits 16-31

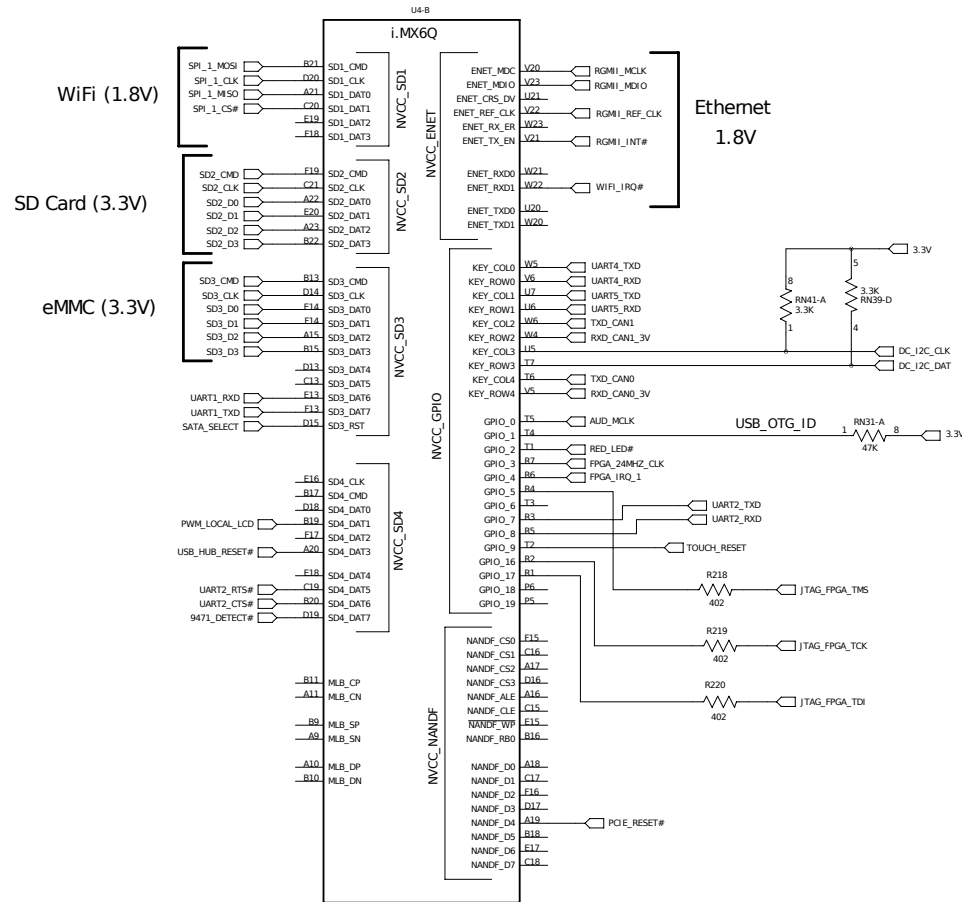


iMX6 Power Pins



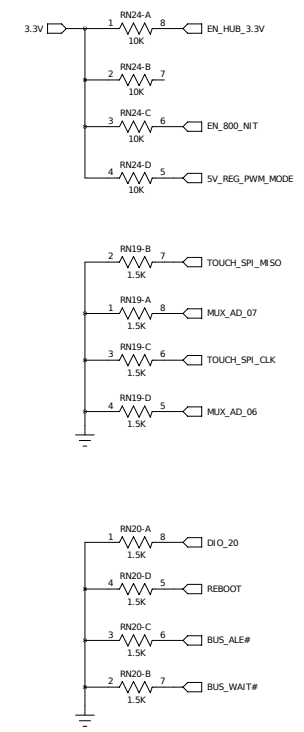
MX6 SINGLE CORE, BGA624
 *Option 1 = NXP MCIMX657CVM08AB (Single Core, 800MHz, I-Temp)
 Option 3 = NXP MCIMX65Q5YM10AC (Quad Core, 1GHz, E-Temp)

SD, GPIO, NAND

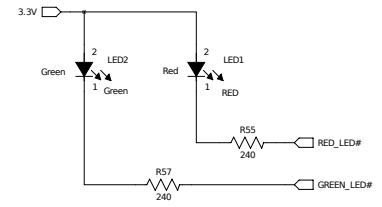


*Option 1 = NXP MCMX6Q5YML0AC (Single Core, 800MHz, I-Temp)
 *Option 3 = NXP MCMX6Q5EYML0AC (Quad Core, 1GHz, E-Temp)

Bias Res.



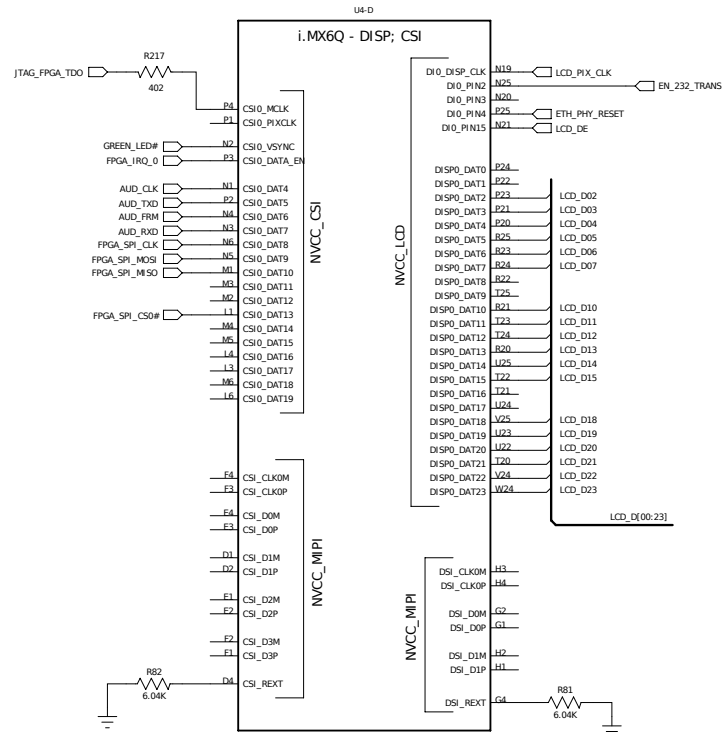
iMX6 LEDs



4 PWM total

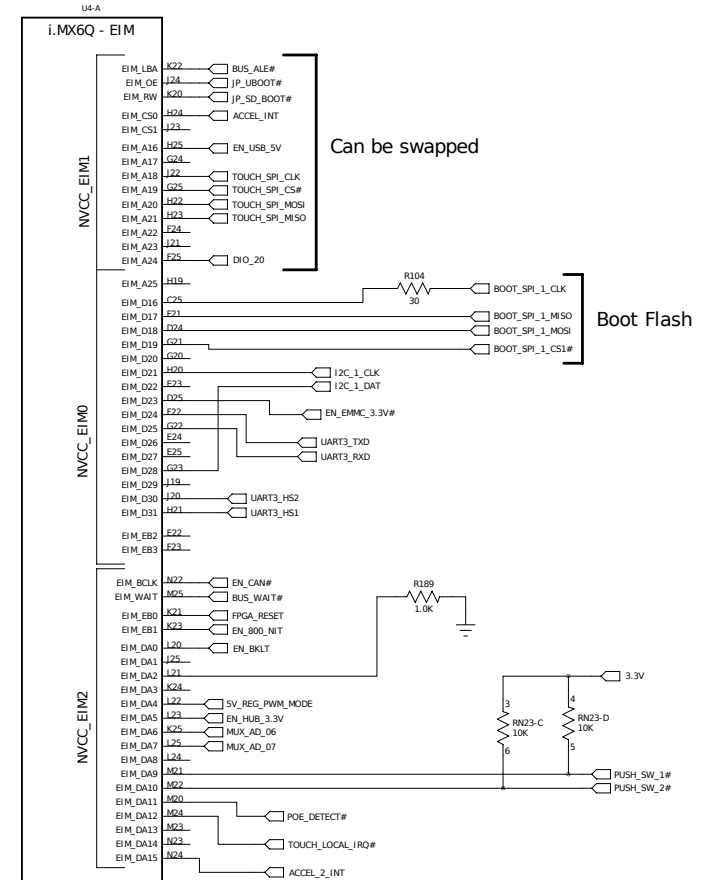
PWM on SD4_DAT 1 or 2
 GPIO_1 and GPIO_9

LCD



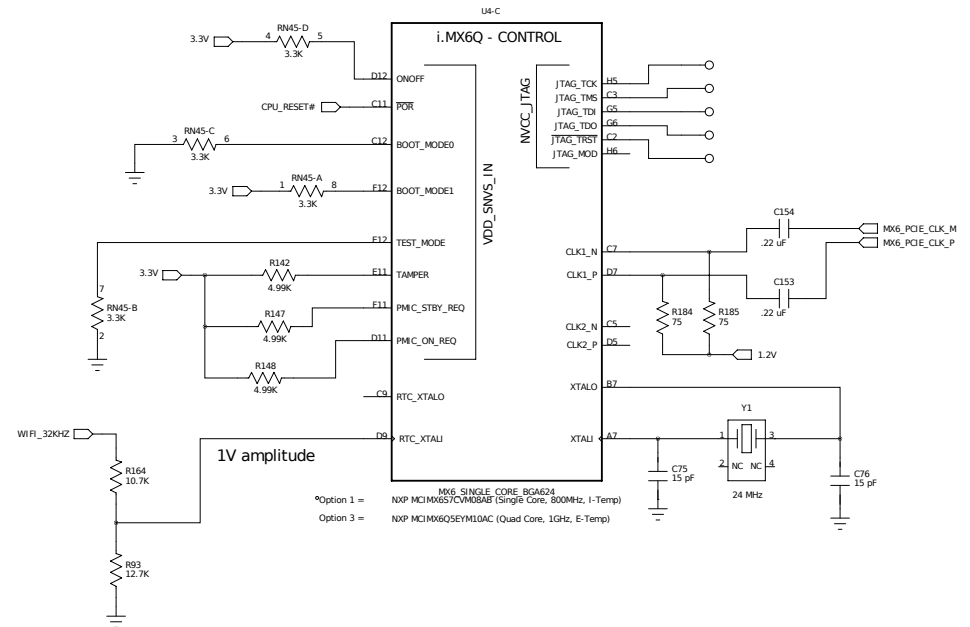
*Option 1 = i.MX6 SINGLE CORE BG6A34
 NXP MCI MX657CVM8B8 (Single Core, 800MHz, I-Temp)
 *Option 3 = NXP MCI MX605EYM10AC (Quad Core, 1GHz, E-Temp)

EIM



*Option 1 = i.MX6 SINGLE CORE BG6A24
 NXP MCI MX657CVM8B8 (Single Core, 800MHz, I-Temp)
 *Option 3 = NXP MCI MX605EYM10AC (Quad Core, 1GHz, E-Temp)

CPU Control



BOOT_MODE

MSB LSB

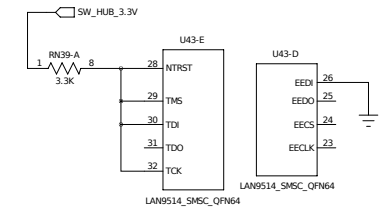
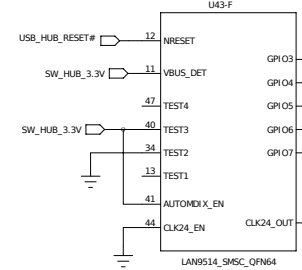
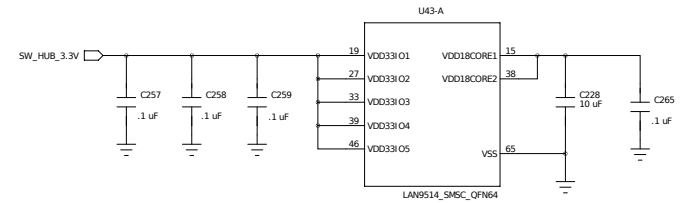
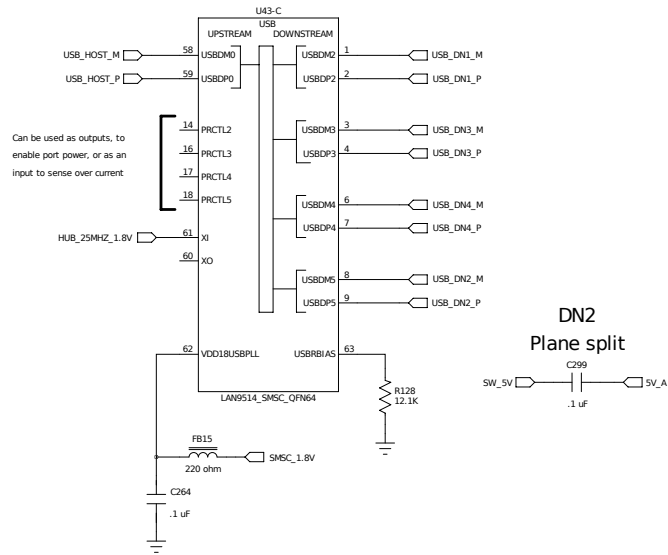
0 0 = Fuses

0 1 = USB

1 0 = Internal Boot

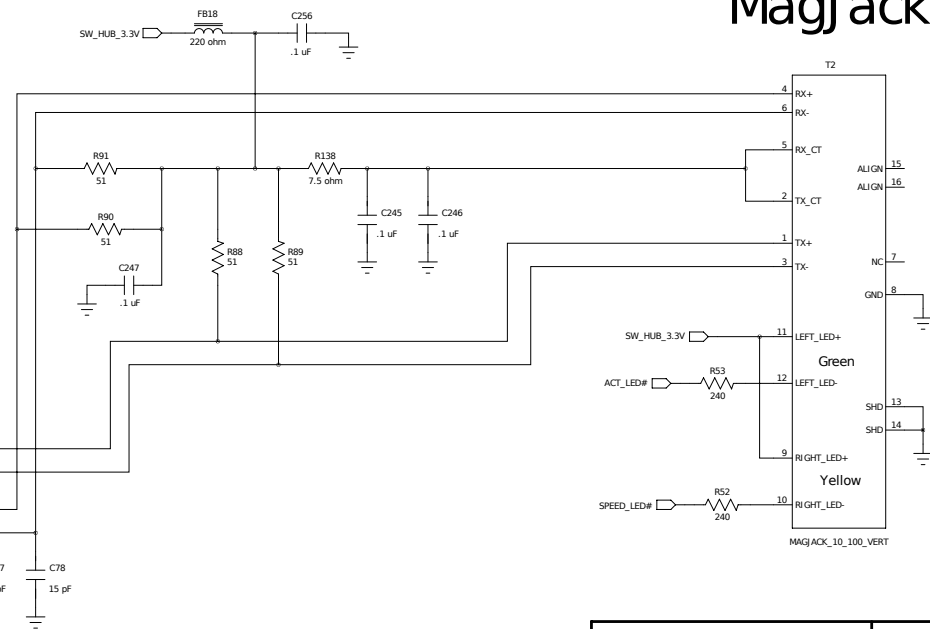
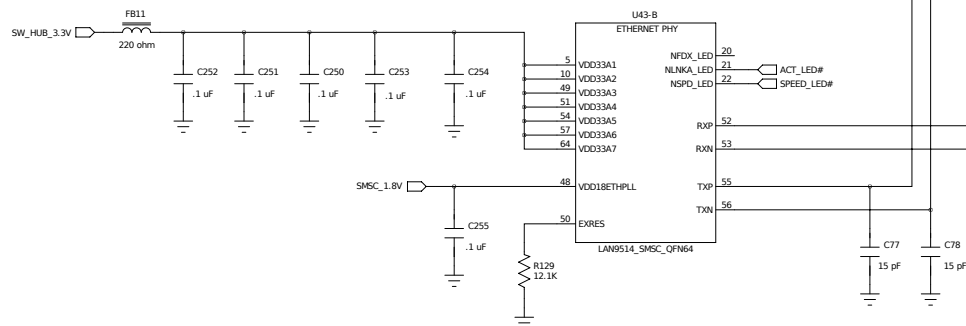
2nd Ethernet Port

SMSC USB Hub



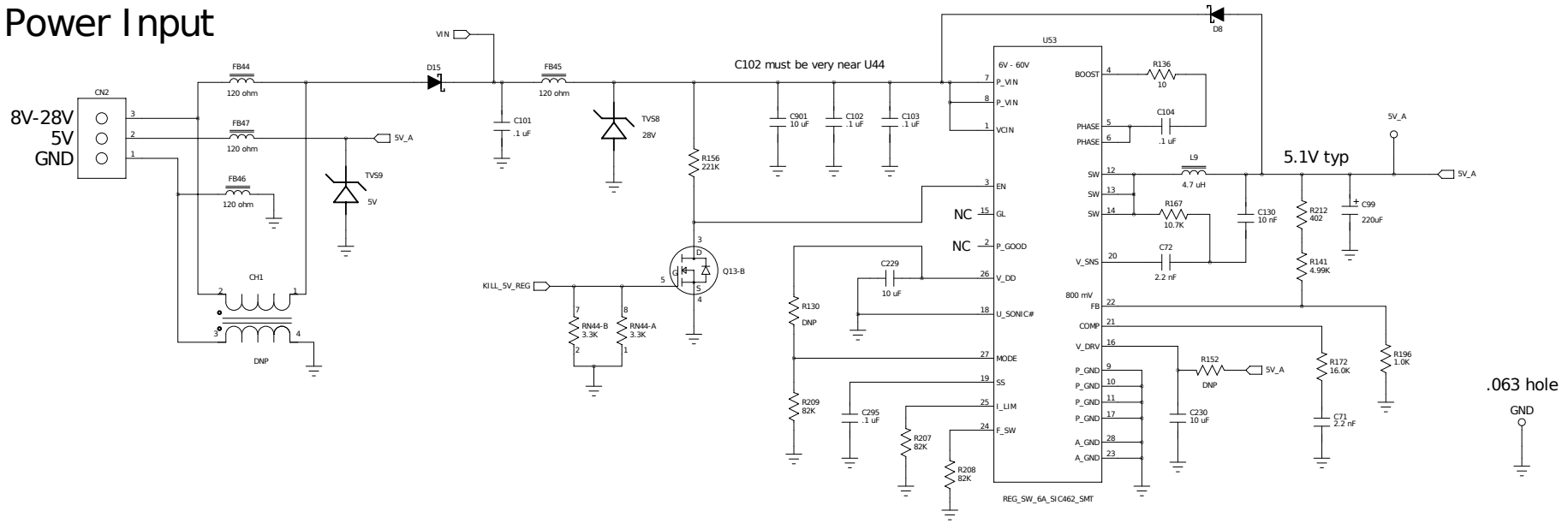
Vert. Magjack

SMSC Ethernet Port

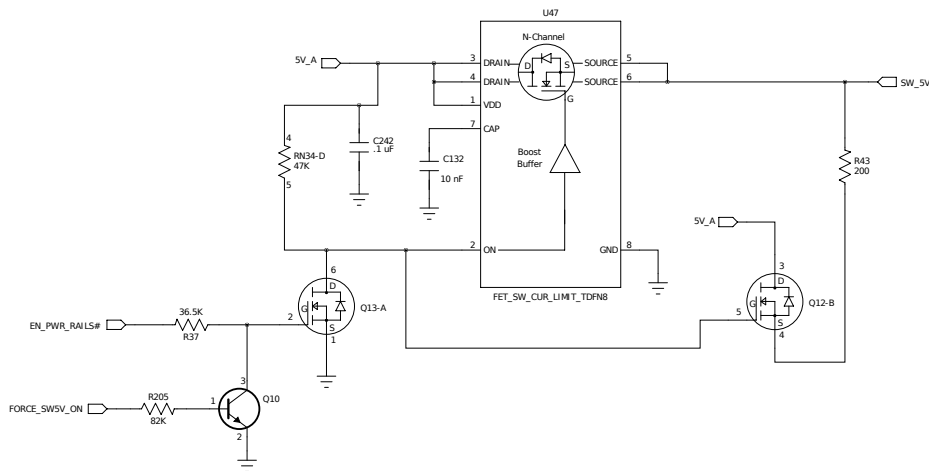


5V Regulator 5A

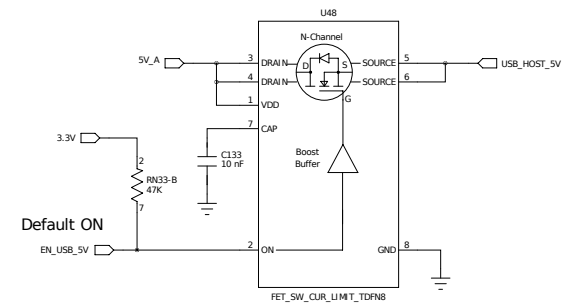
Power Input



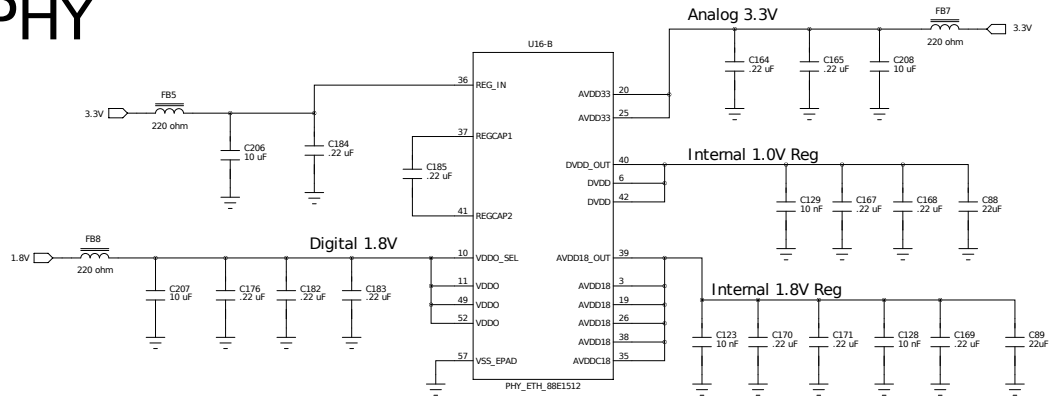
Main 5V Power Sw.



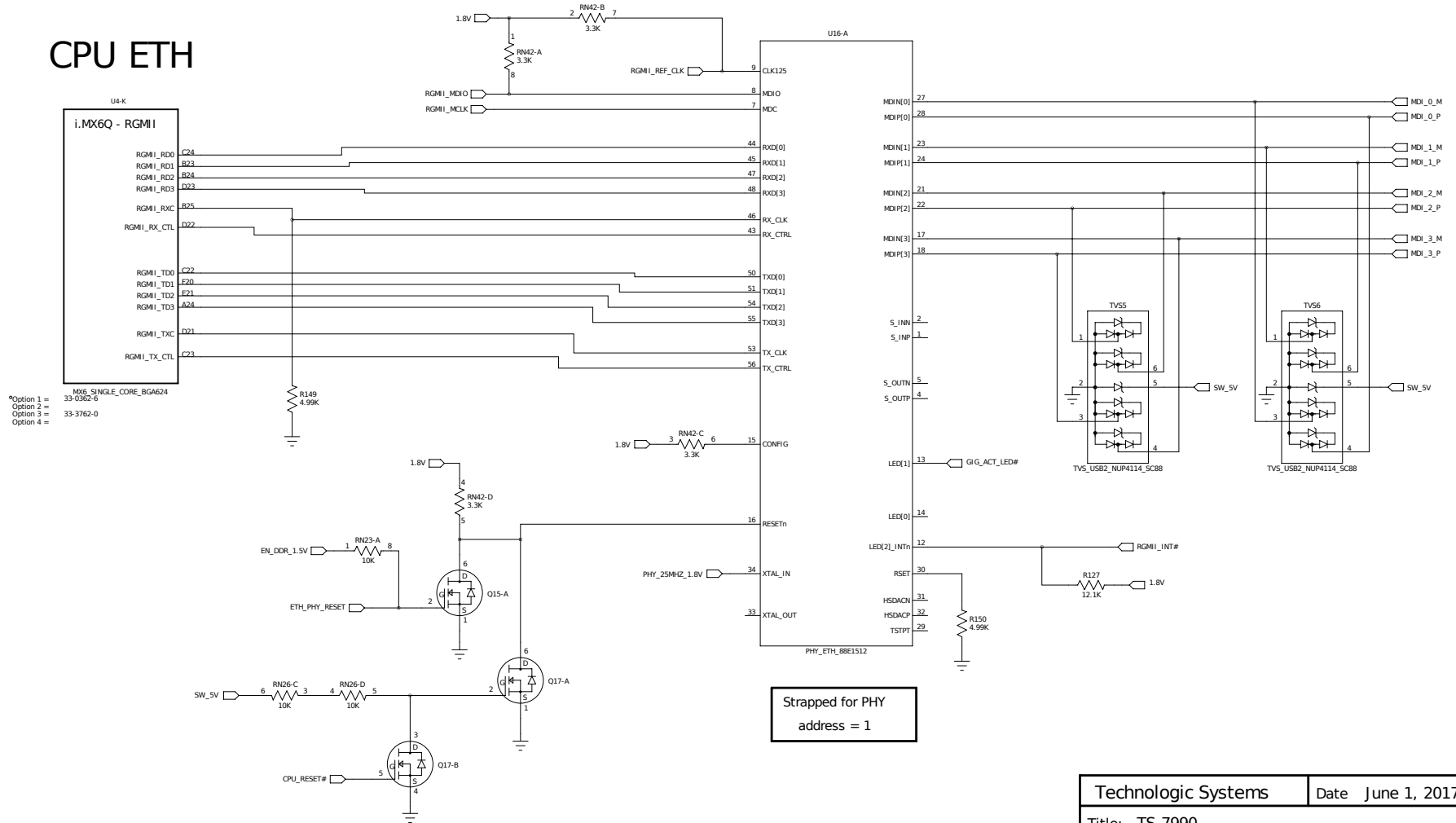
USB Sw. 5V



10/100/1000 Ethernet PHY



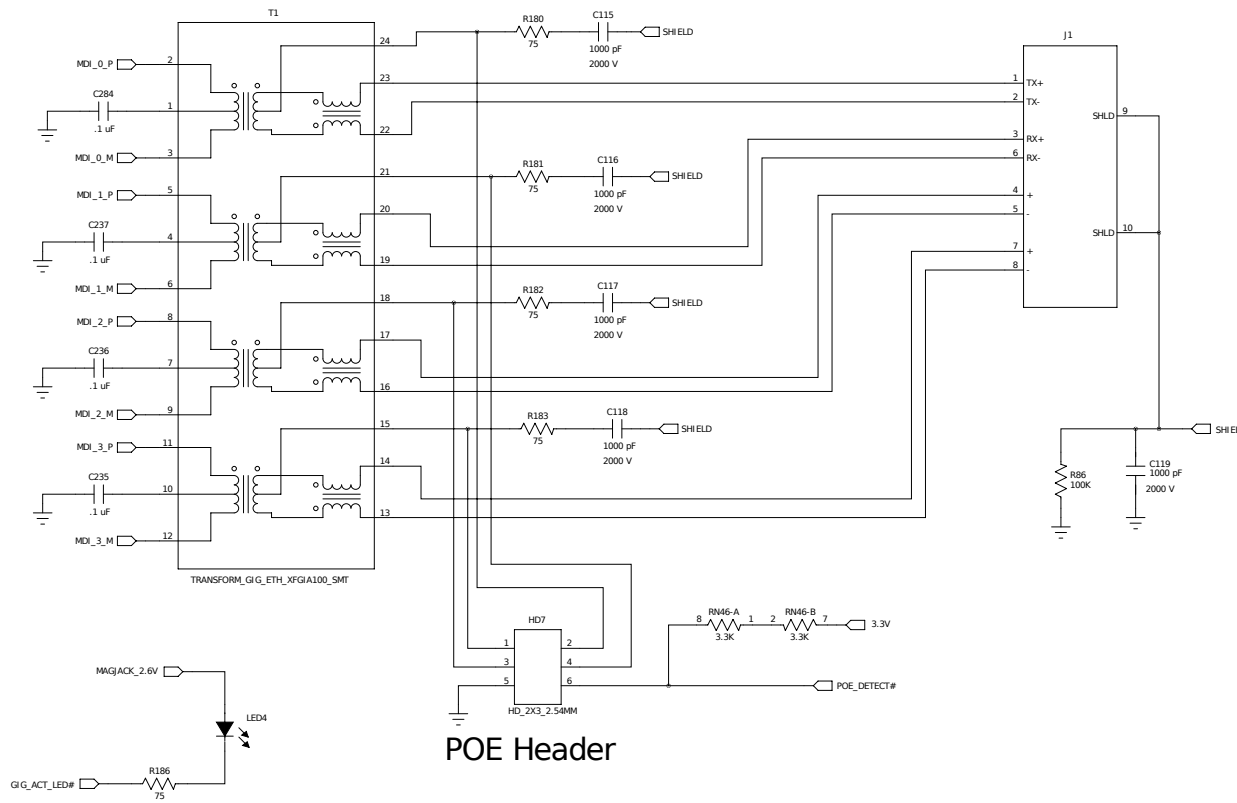
CPU ETH



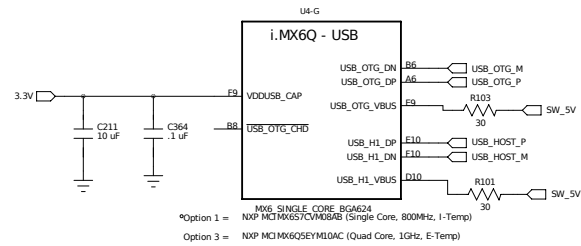
Strapped for PHY
address = 1

Gig Eth Transformer

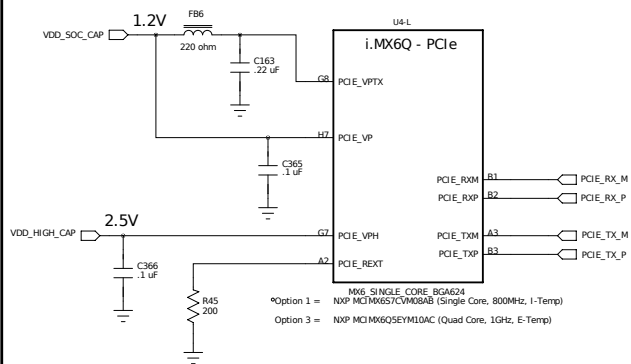
Vertical RJ45



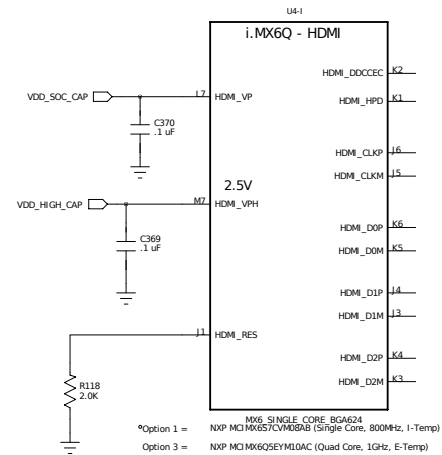
CPU USB

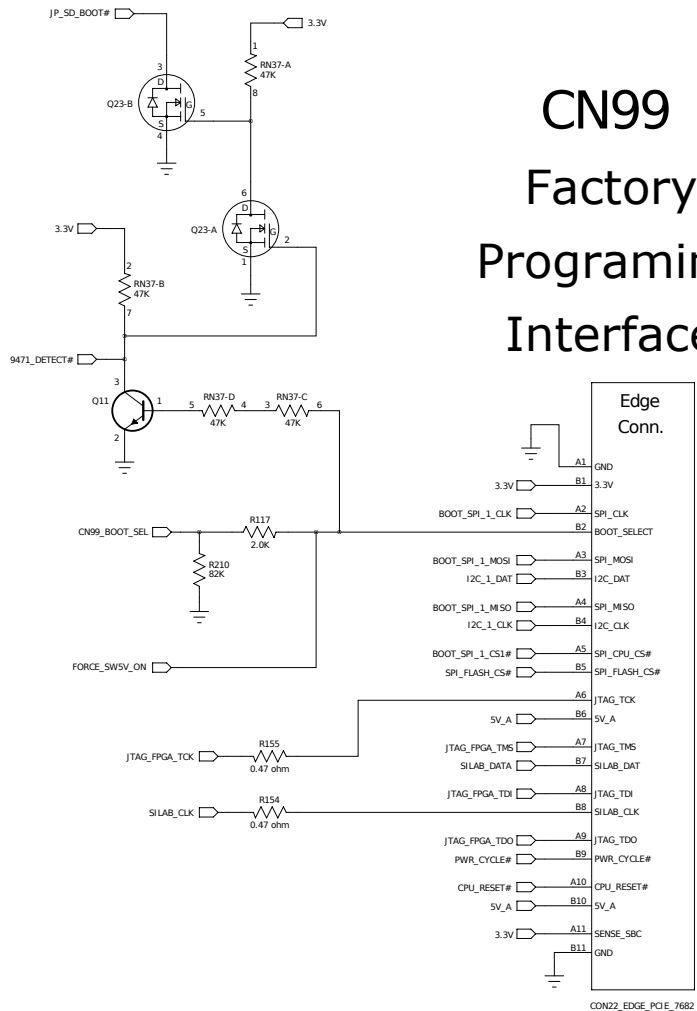


CPU PCIe

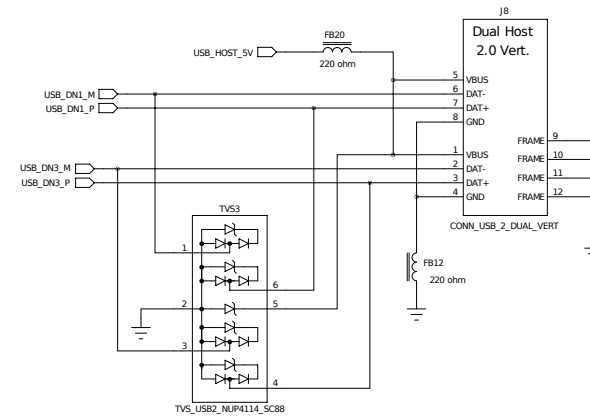


CPU HDMI

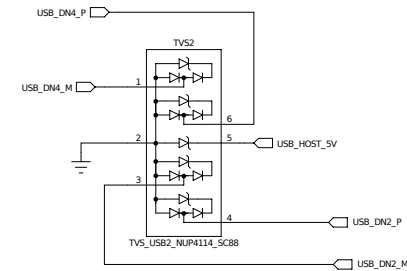




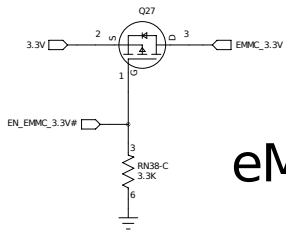
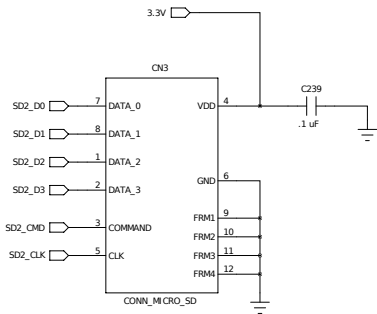
USB Host Vert. Ports



Mini-PCIe and Modem USB TVS

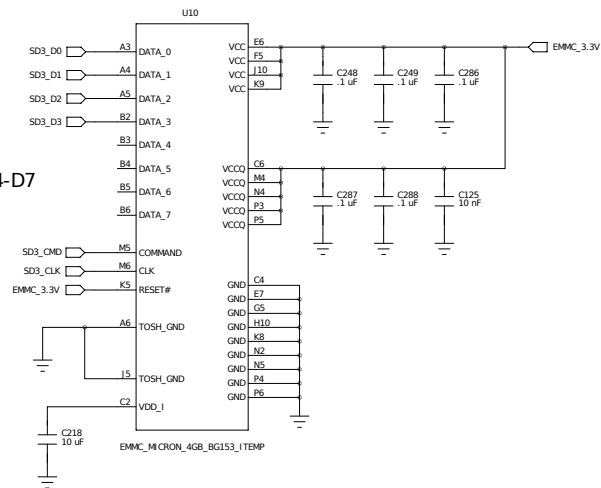


Micro SD Card Socket

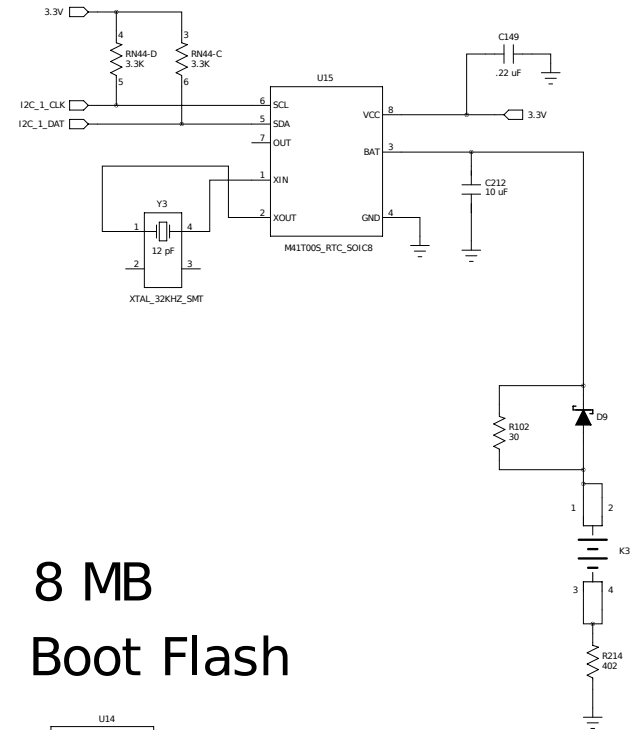


eMMC 4GB

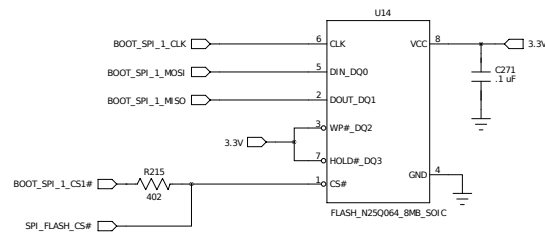
Internal PU on D4-D7



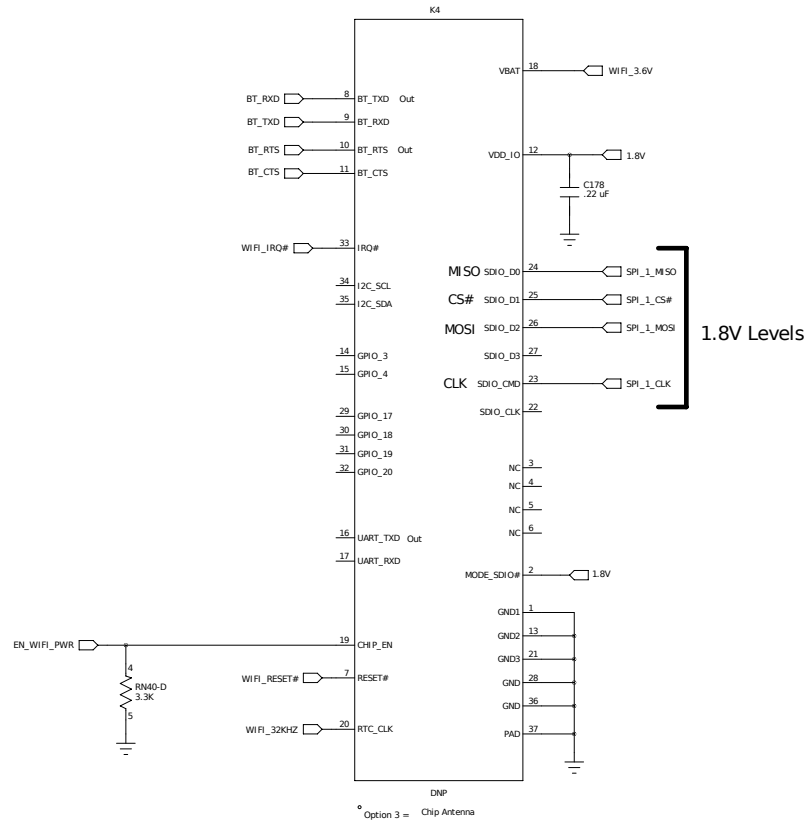
ST Micro RTC



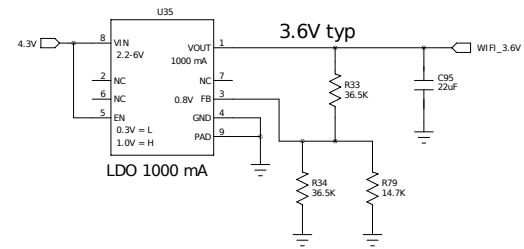
8 MB SPI Boot Flash



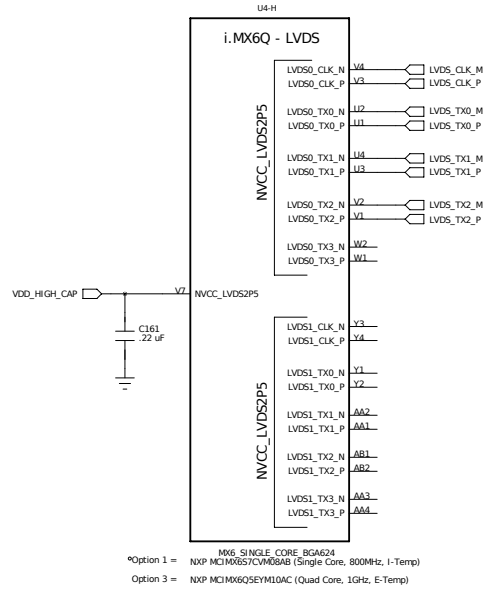
WiFi / Bluetooth Radio Module



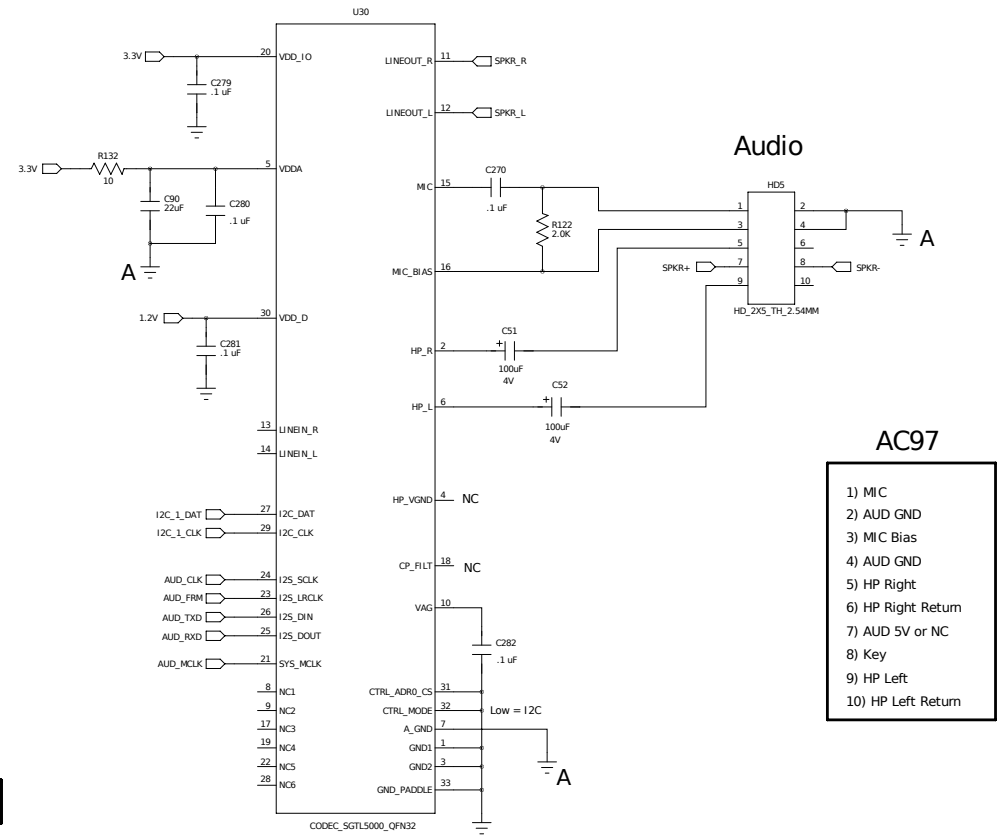
WiFi 3.6V Regulator



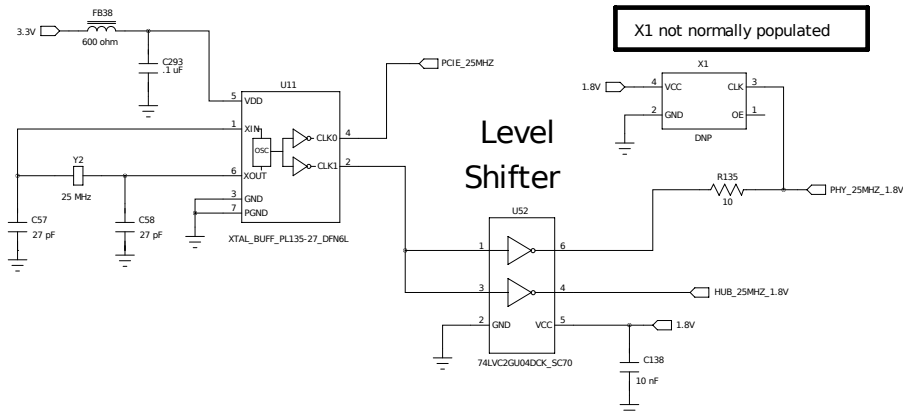
LVDS



Audio CODEC



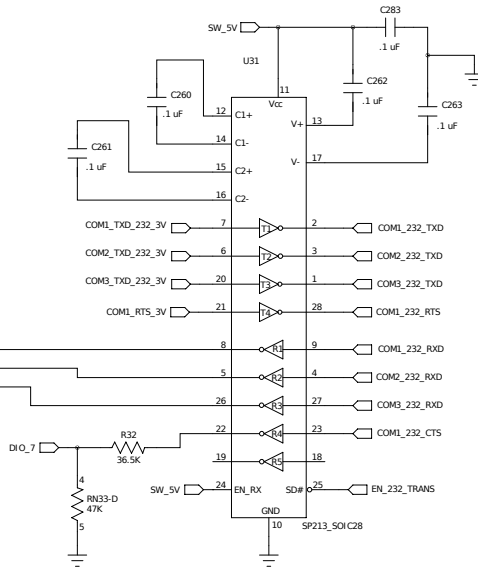
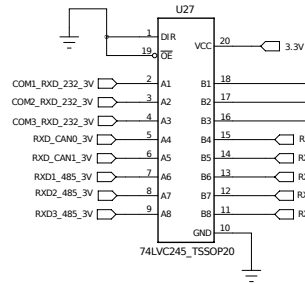
25 MHz Osc.



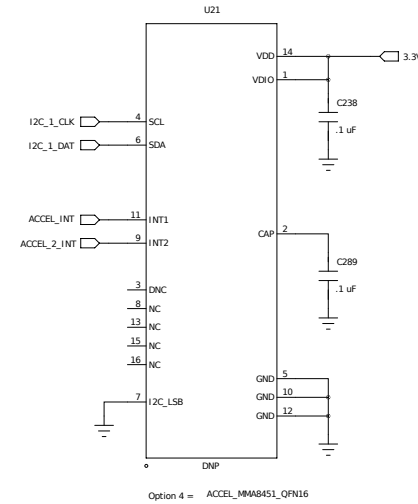
RS-232 Transceiver and COM Headers

RS-232 Transceiver

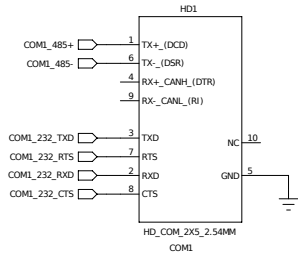
3.3V <-- 5V
Level shifter



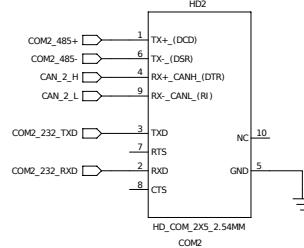
Accelerometer



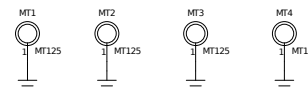
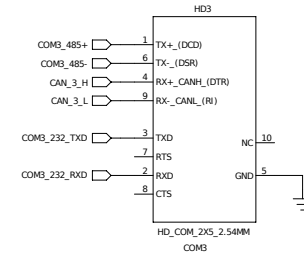
COM1 Header



COM2 Header



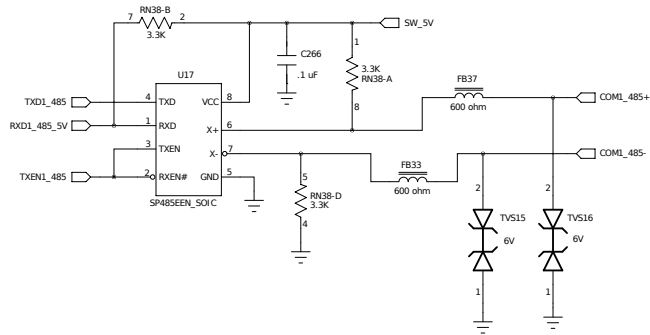
COM3 Header



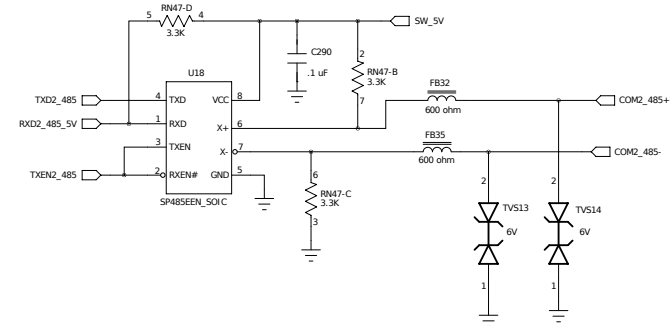
Technologic Systems		Date	June 1, 2017
Title: TS-7990			
Rev: C	Designer	Sheet 20 of 30	

RS-485 and CAN Transceivers

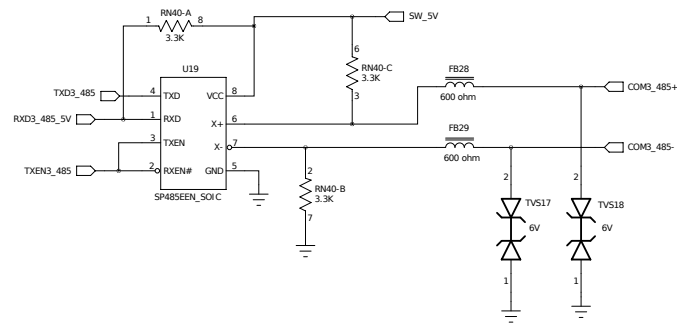
COM1 RS-485 Driver



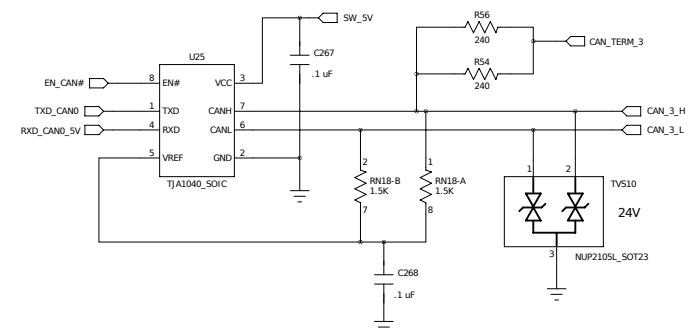
COM2 RS-485 Driver



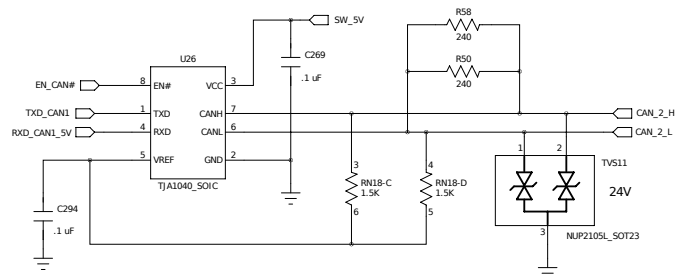
COM3 RS-485 Driver



COM3 CAN Transceiver



COM2 CAN Transceiver

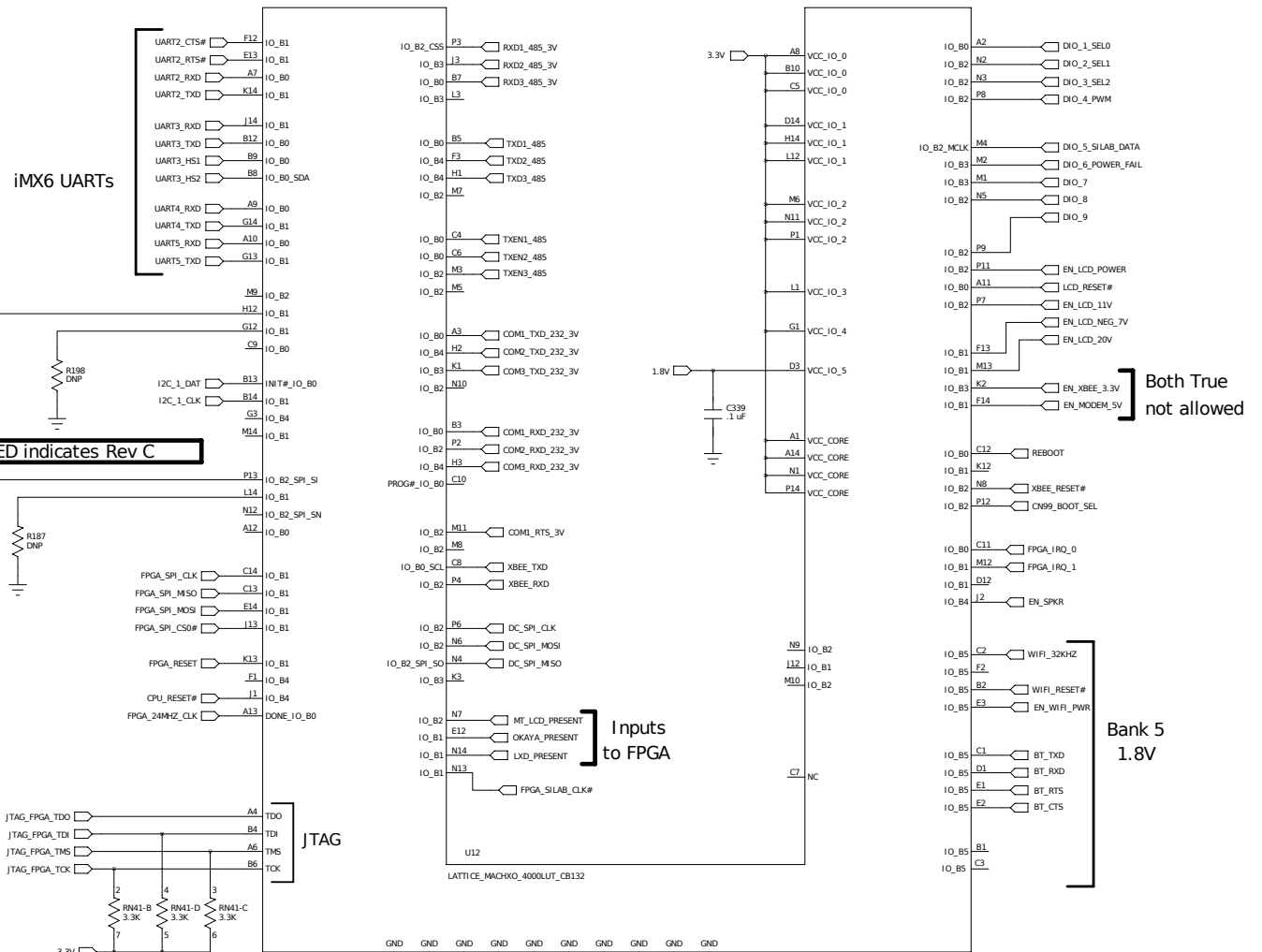


Technologic Systems		Date June 1, 2017
Title: TS-7990		
Rev: C	Designer	Sheet 21 of 30

MACH XO2 FPGA

FPGA required for:

- Adds two MAX3100 UART via SPI
- Auto-485 for 3 UARTs
- Provides serial port MUXing
- Level shifting for Bluetooth
- Controls LCD power sequencing
- Option strap resistors
- DIO for DC

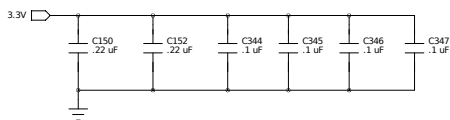
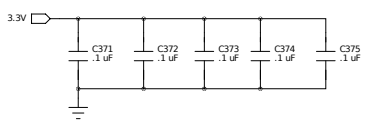


R198 REMOVED indicates Rev C

Resistor Strapping Table

MSB	LSB	Option	Part Number
0	0	Option 1	TS-TPC-7990-SMNxE
0	1	Option 3	TS-TPC-7990-QMWxE

0 = POP, 1 = DNP

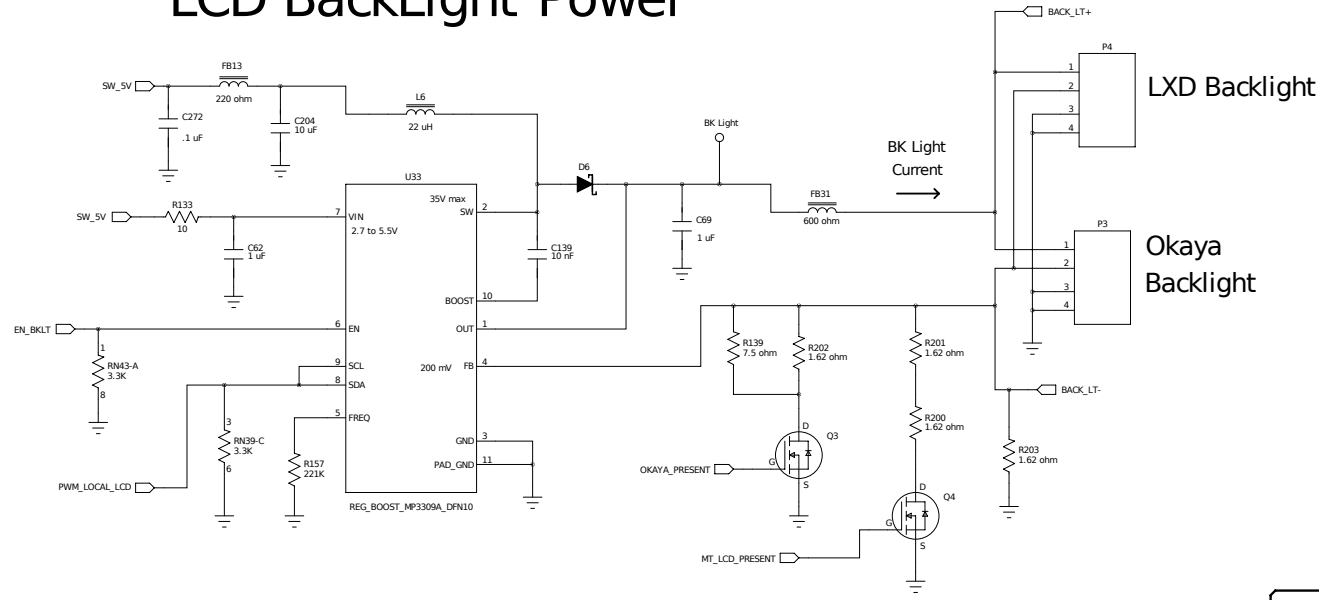


FPGA Features:

- Programmable PU or PD on each pin.
- Internal 2 MHz clock; 10 MHz min PLL clock
- special function pins are in unpredicable states the 1st 1 ms
- All DIO have Hysteresis inputs

At power up, all DIO must be tri-stated

LCD BackLight Power

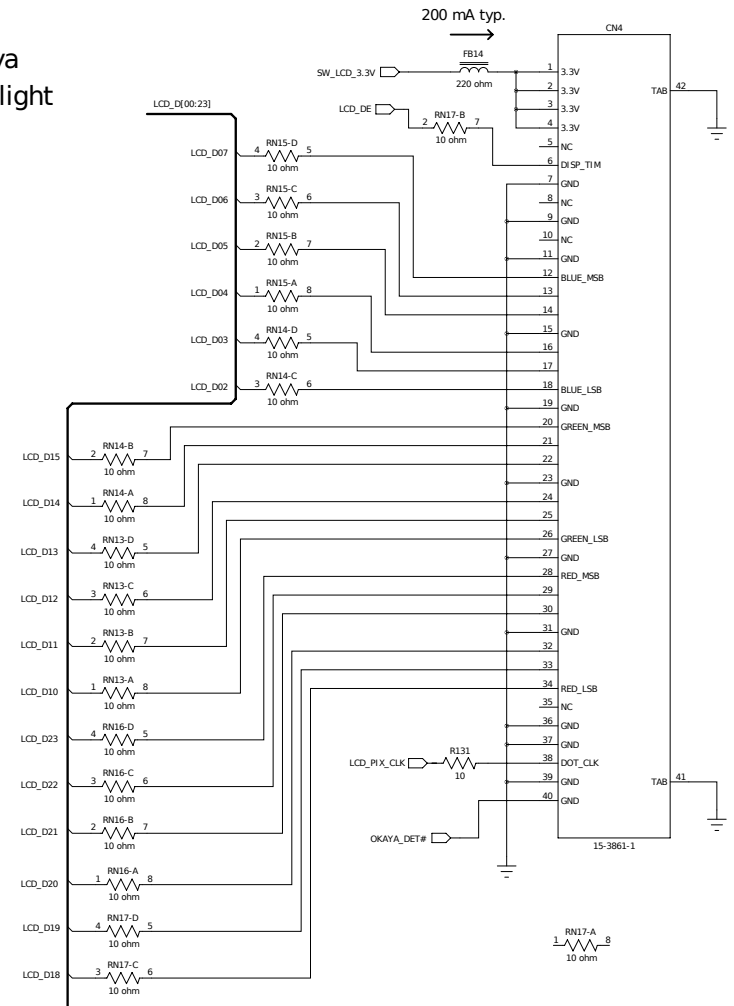


MT Backlight is on CN8

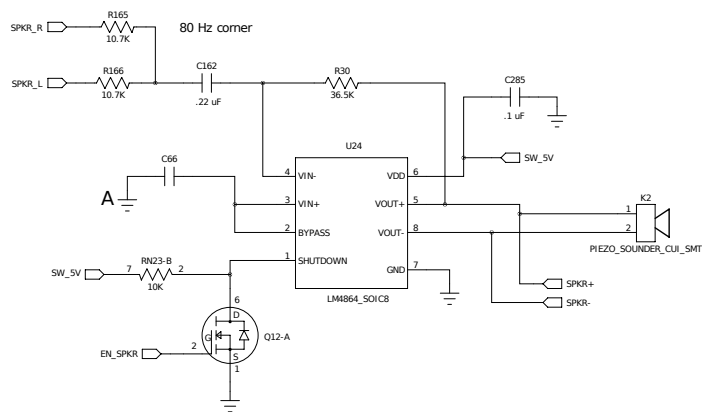
LXD Backlight

Okaya Backlight

Okaya LCD Conn.

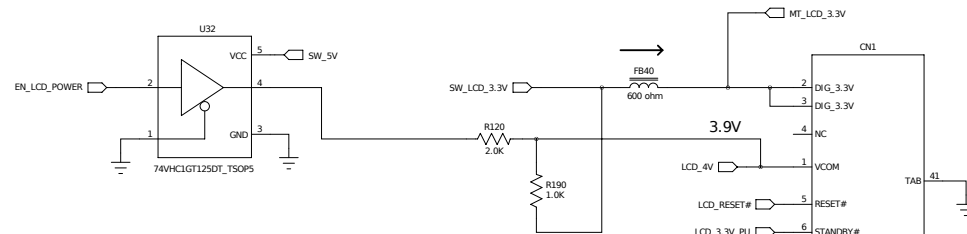


Speaker Amp

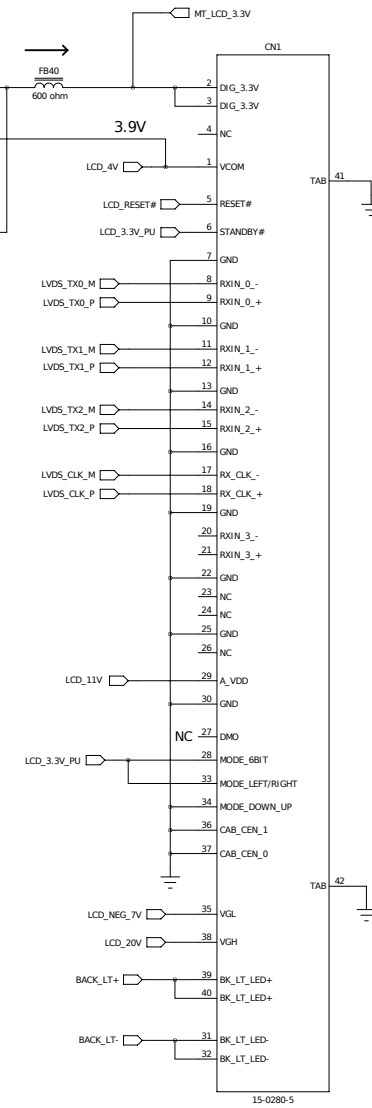
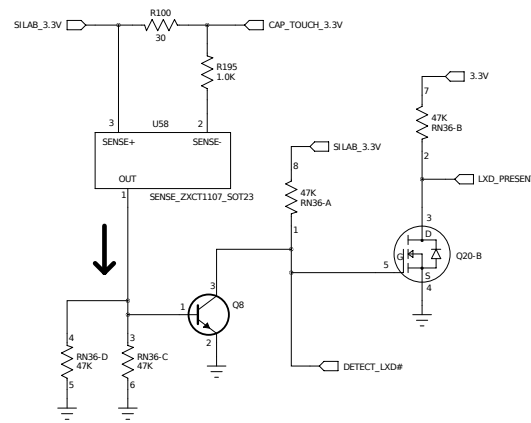


LVDS LCD Conn. LCD

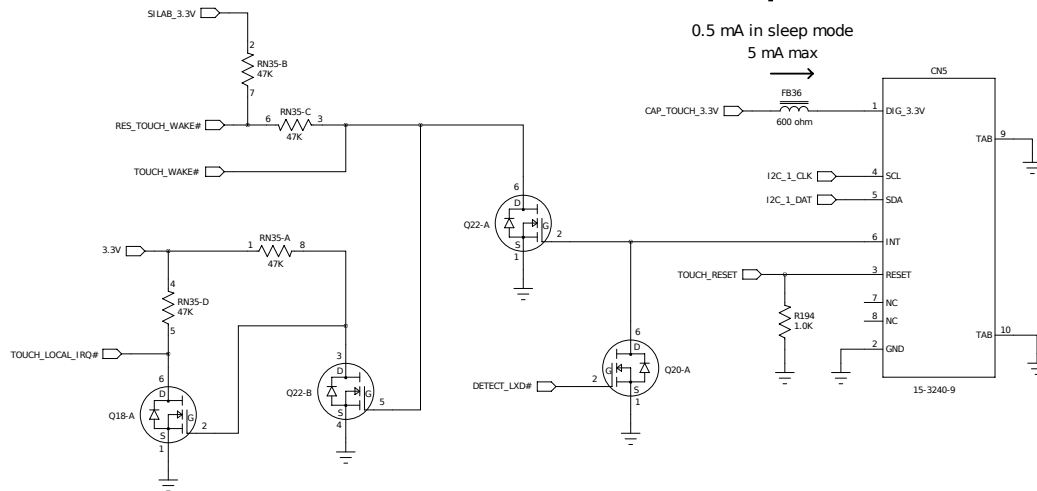
LXD LCD Conn.



Cap Touch Detect

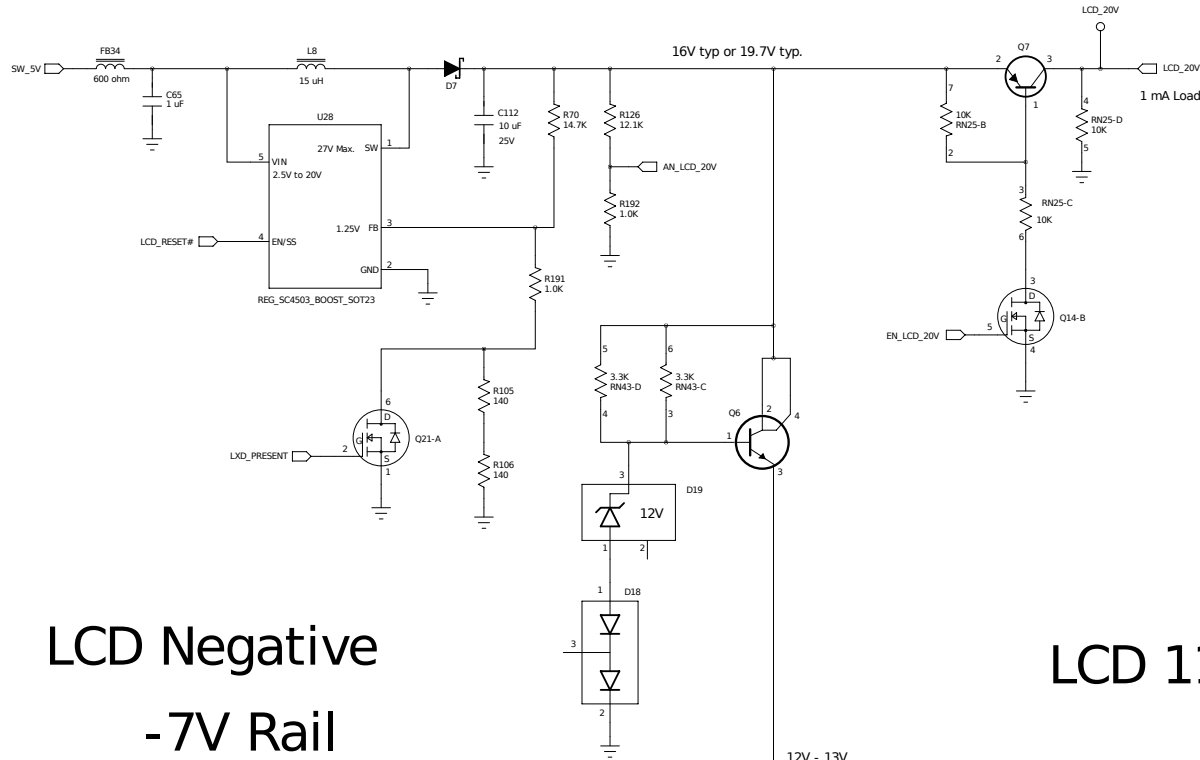


LXD Cap. Touch Conn.

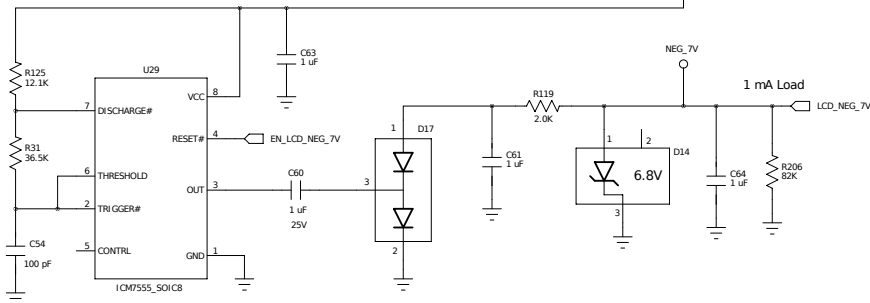


LXD and MT LCD Power Rails

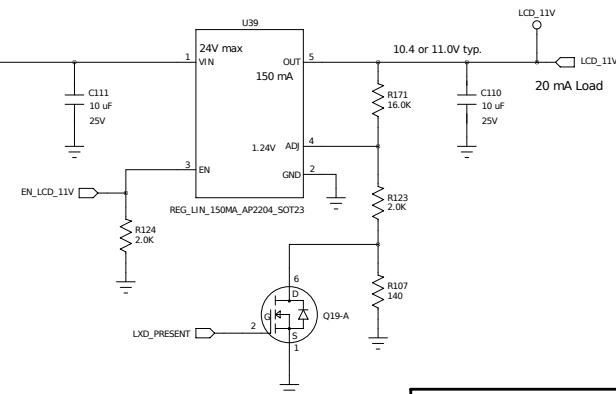
LCD +20V/16V Power Supply



LCD Negative -7V Rail



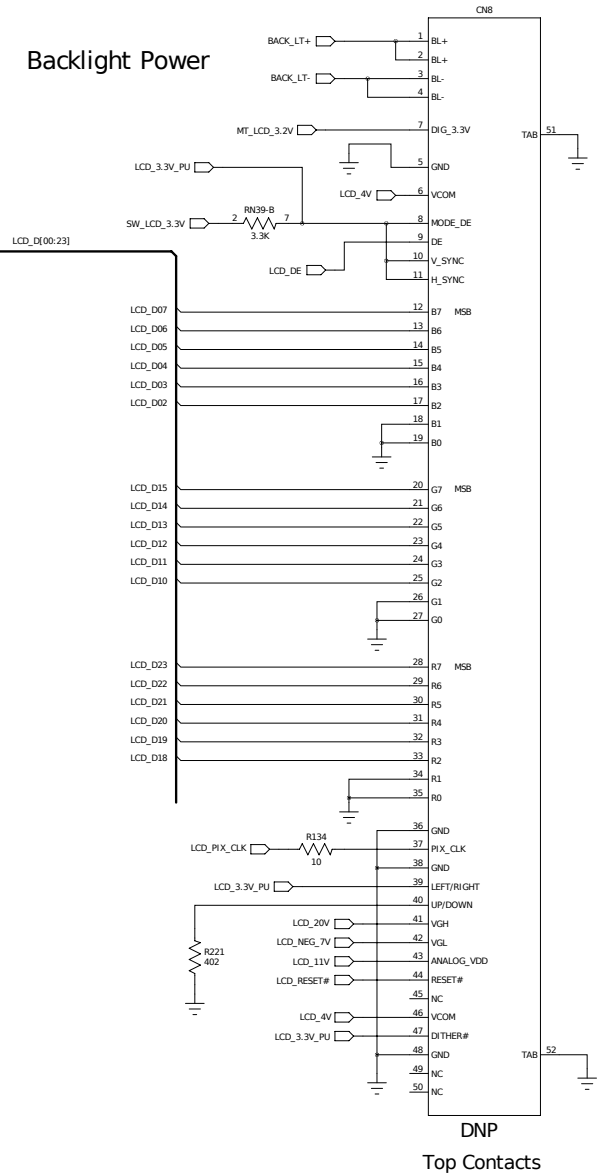
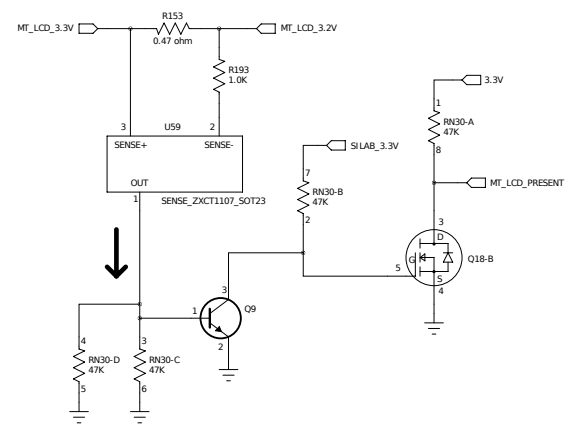
LCD 11V/10.4V Power Supply



Technologic Systems		Date June 1, 2017
Title: TS-7990		
Rev: C	Designer	Sheet 25 of 30

MicroTips LCD Conn.

MT LCD Detect

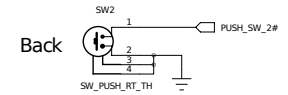
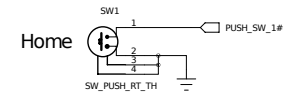
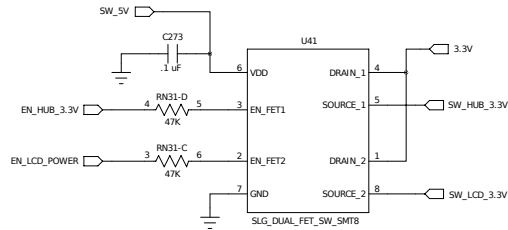


Technologic Systems		Date	June 1, 2017
Title: TS-7990			
Rev: C	Designer	Sheet 26 of 30	

LCD Res. Touch

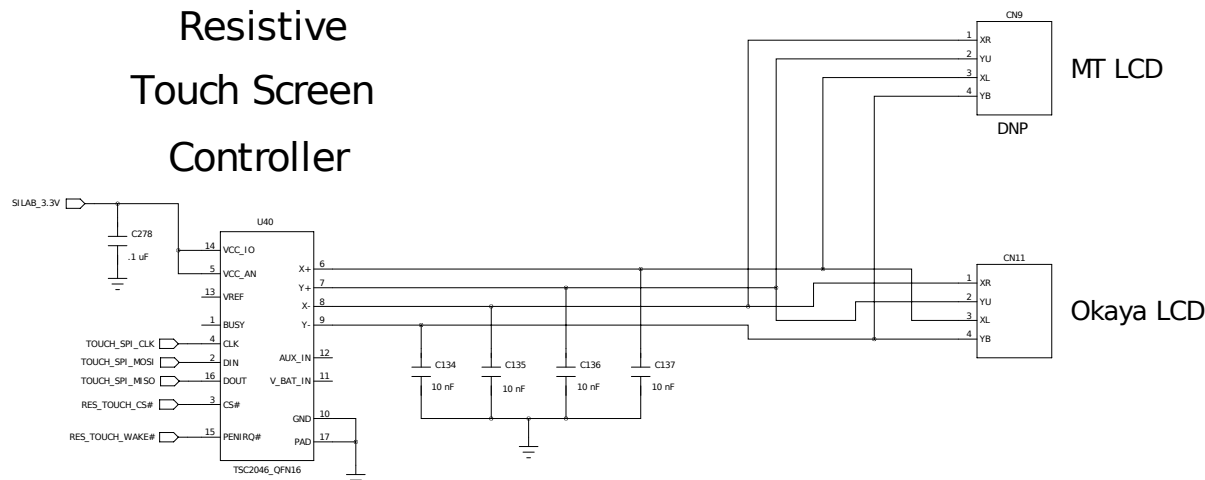
Android Push Switches

Hub and LCD Power Switch



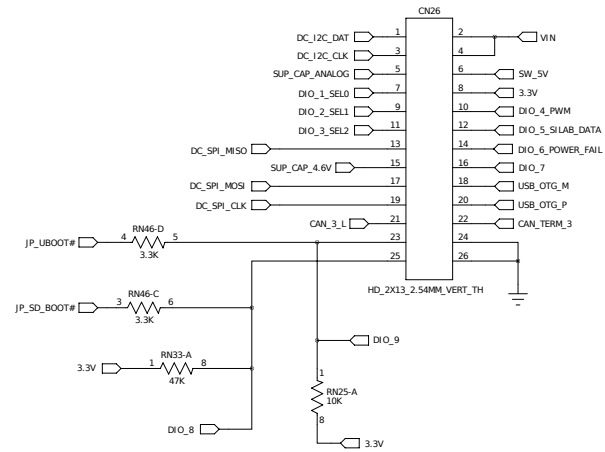
Touch Screen Connectors

Resistive Touch Screen Controller

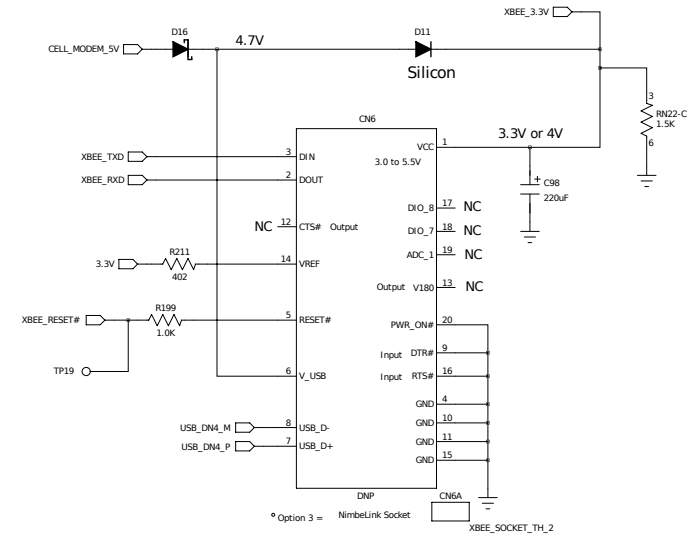


Technologic Systems	Date June 1, 2017
Title: TS-7990	
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Sheet 27 of 30	

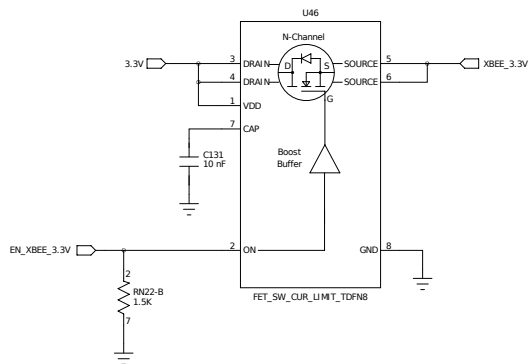
DIO Port and Jumpers



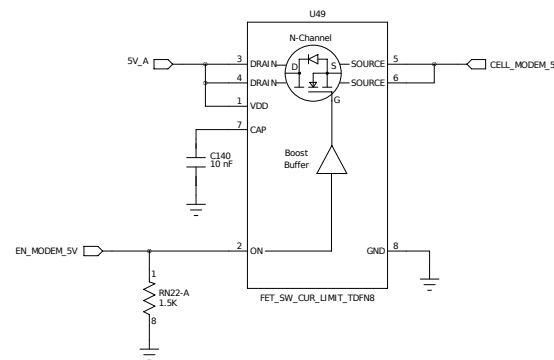
NimbeLink Modem Socket



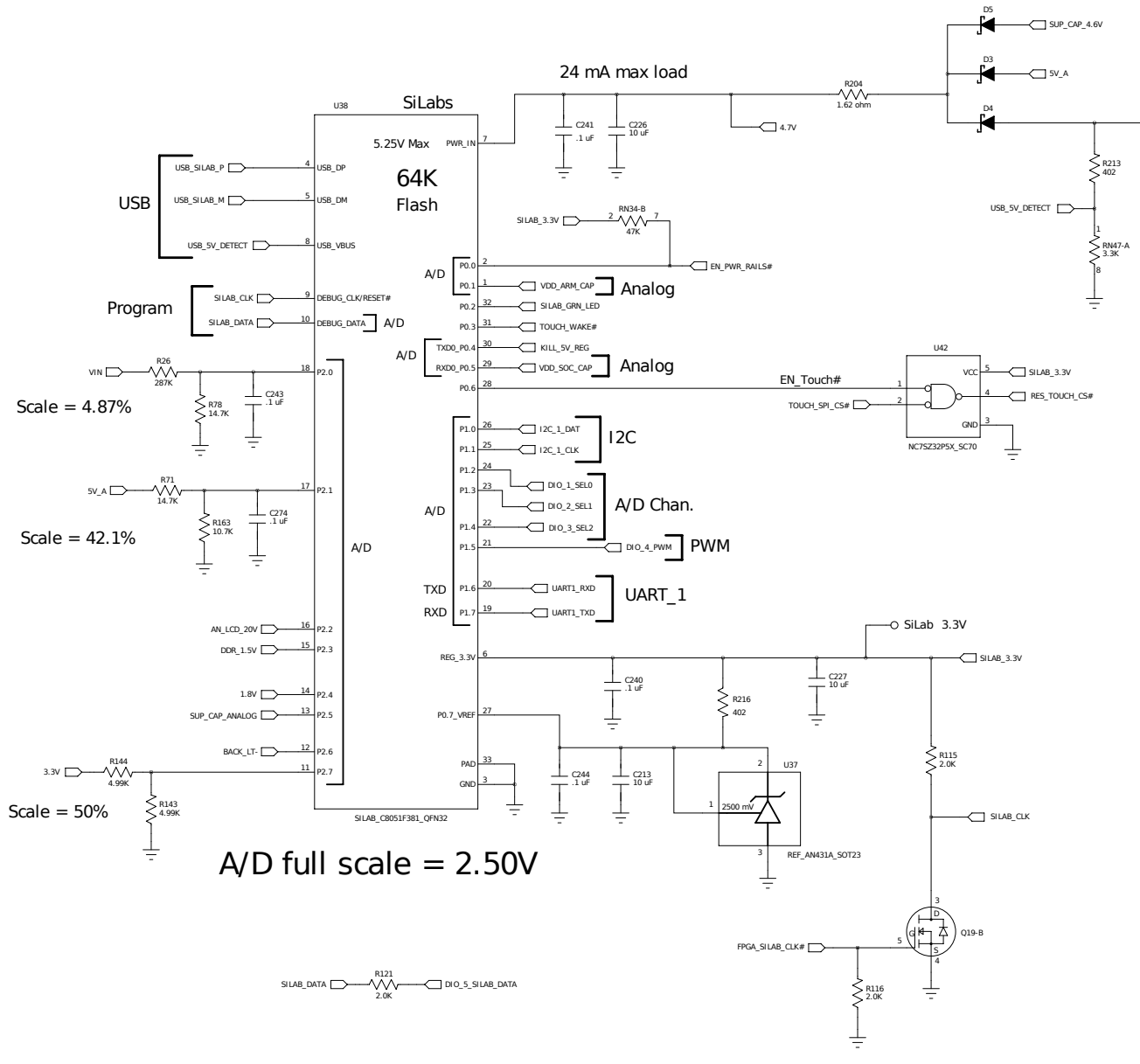
3.3V Sw.



NimbeLink 5V Sw.



USB Device Port and Silab uC



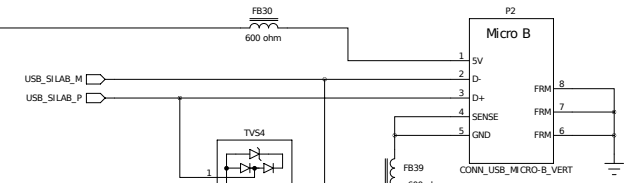
Scale = 4.87%

Scale = 42.1%

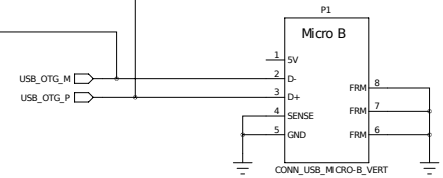
Scale = 50%

A/D full scale = 2.50V

USB Device Port Console

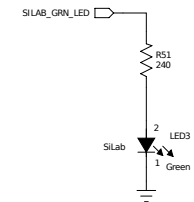


OTG



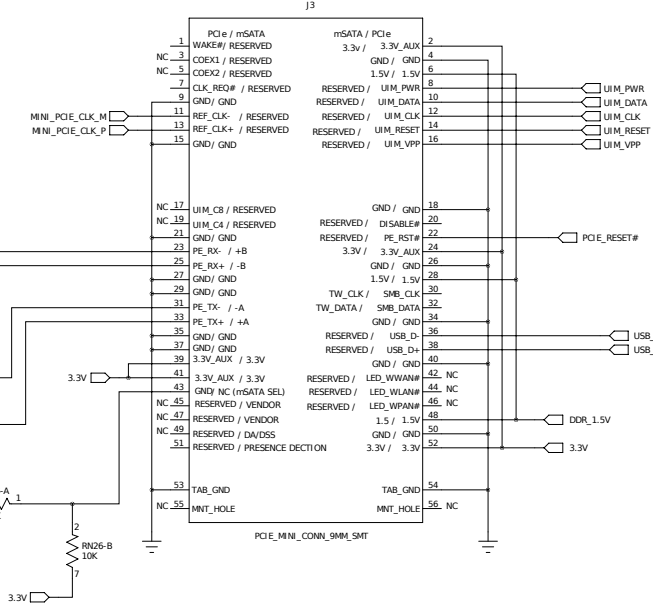
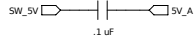
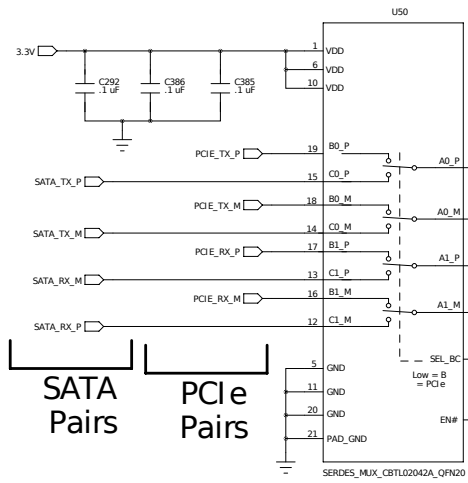
Device Only

SiLab LED



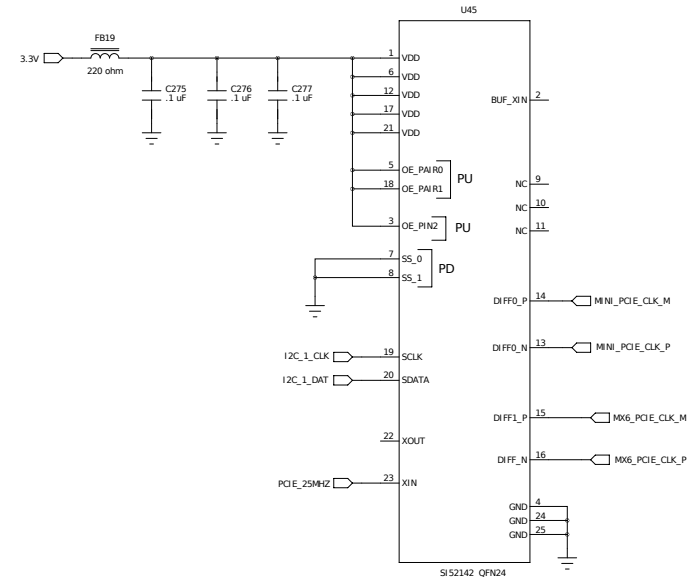
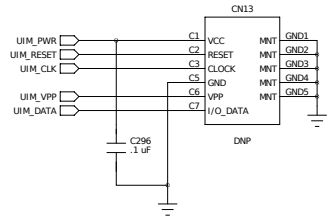
7mm Stack Height to bd. center

SERDES MUX

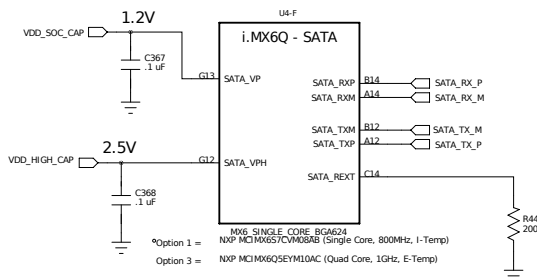


PCIe 100 MHz Clock Gen.

SIM Card Conn.



SATA



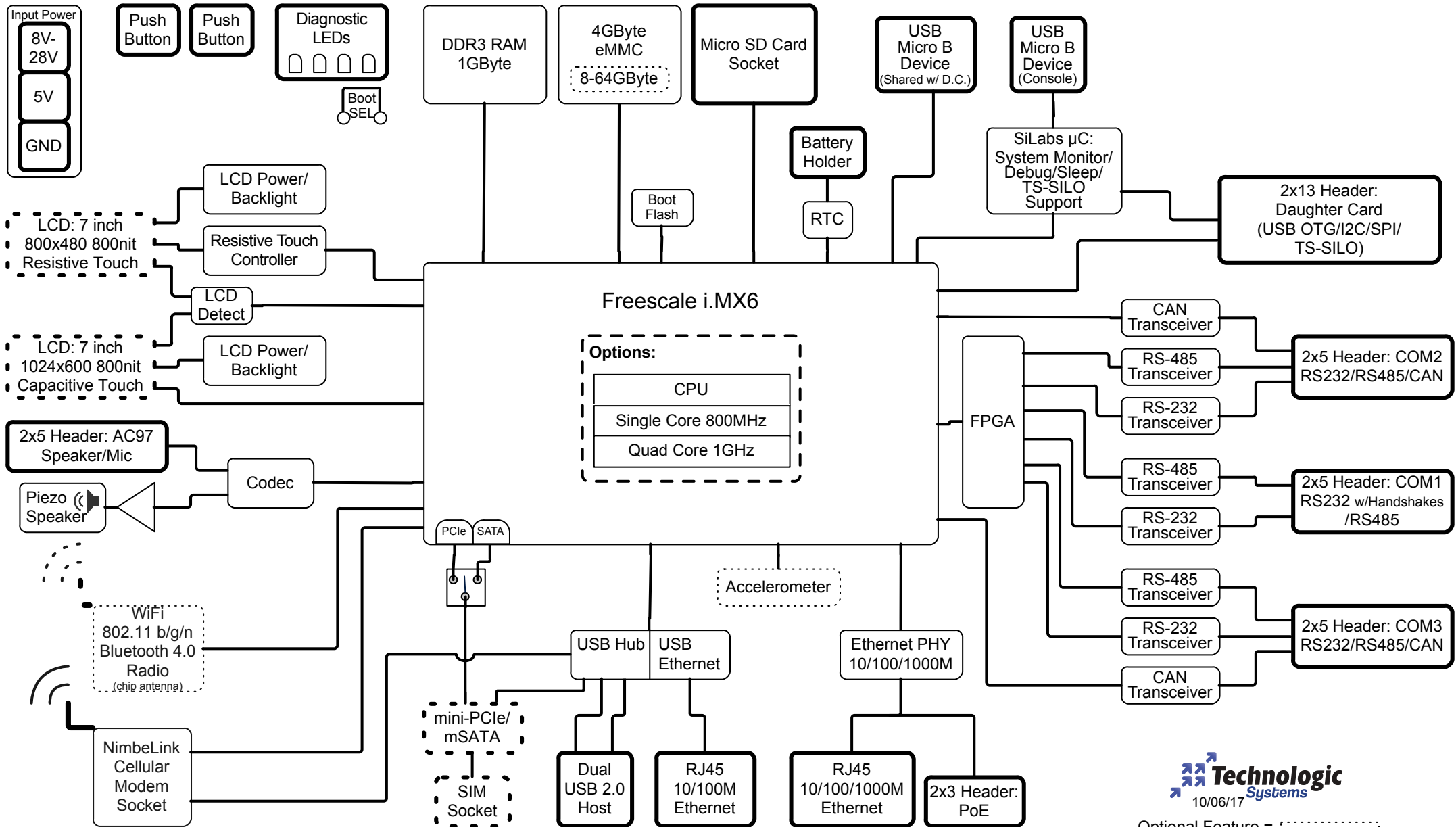
MX6 SINGLE CORE BGA624
 Option 1 = NXP MCMX657CVMB0B (Single Core, 800MHz, I-Temp)
 Option 3 = NXP MCMX650EYM10AC (Quad Core, 1GHz, E-Temp)



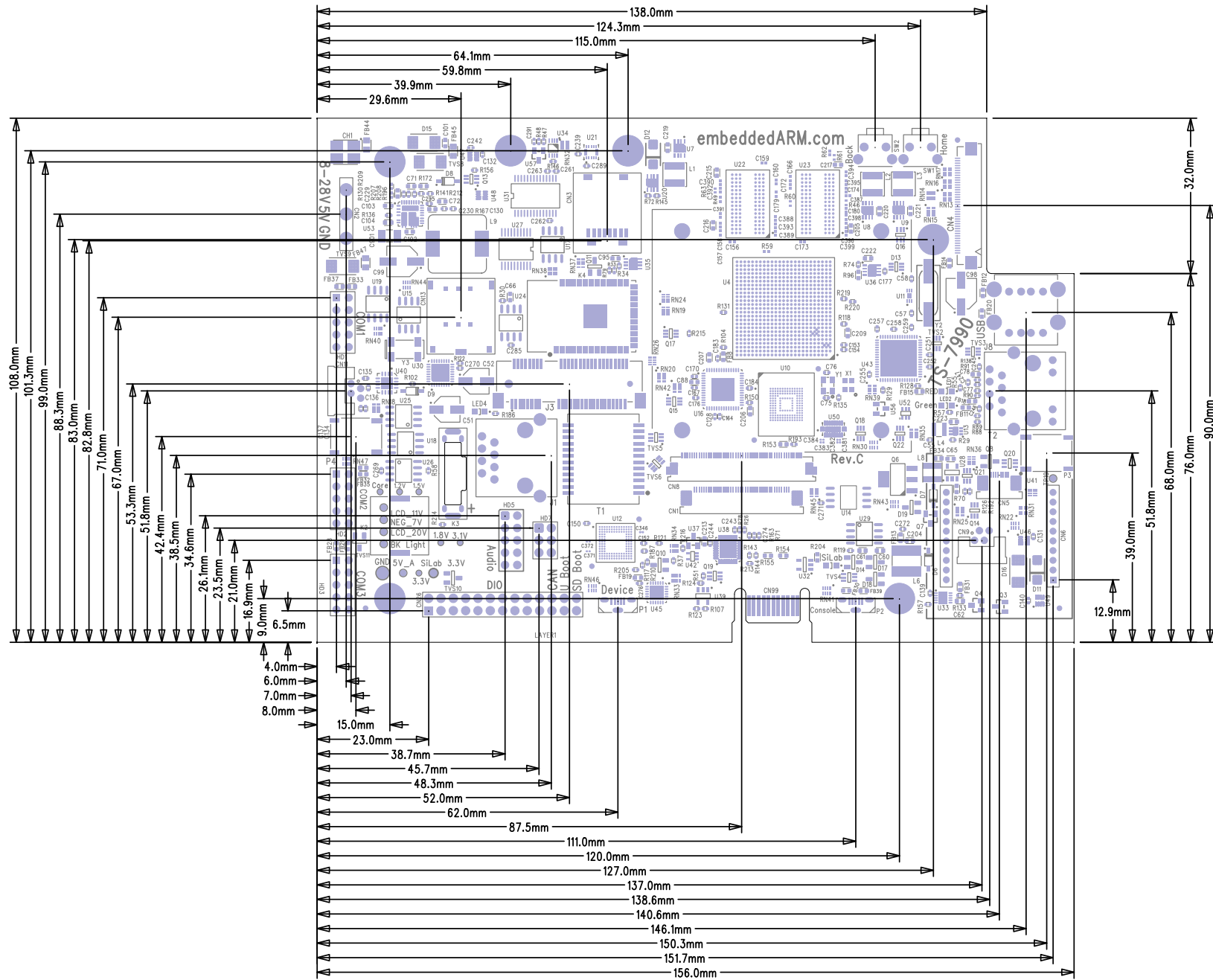
Technologic Systems		Date	June 1, 2017
Title: TS-7990			
Rev: C	Designer	Sheet 30 of 30	

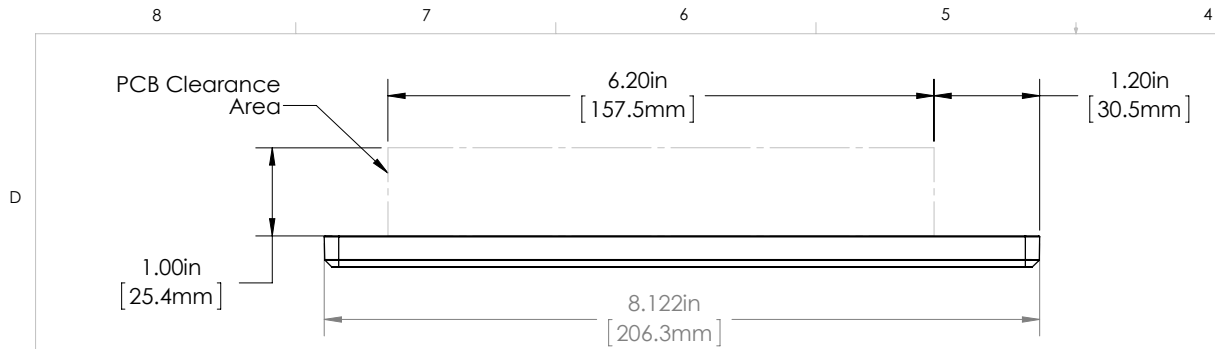
System Level Block Diagram

TS-TPC-7990 Rev C

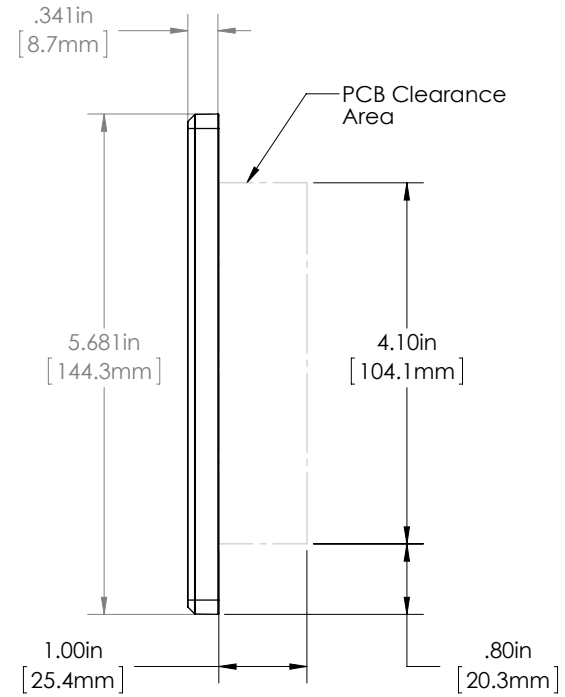
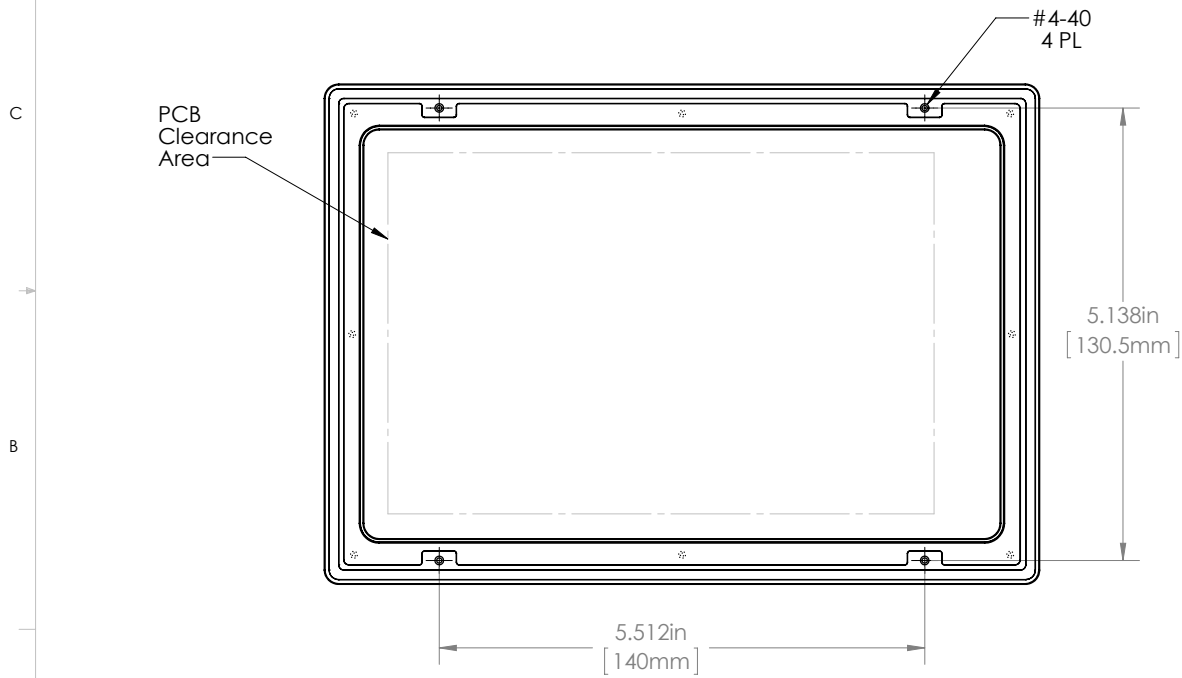


MECHANICAL DRAWING TS-7990





REVISIONS				
ZONE	REV.	DESCRIPTION	DATE	APPROVED
	A0.0	Original Release	9/23/2016	JRK



GENERAL NOTES:

1. All dimensions in Inches and [Millimeters]

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NEXT ASSY	USED ON	APPLICATION
		DO NOT SCALE DRAWING

UNLESS OTHERWISE SPECIFIED:

DIMENSIONS ARE IN INCHES
 TOLERANCES:
 FRACTIONAL ± 1/64
 ANGULAR: MACH ± .25° BEND ± 1°
 x.xxx ± .005
 x.xx ± .010
 x.x ± .020
 INTERPRET GEOMETRIC TOLERANCING PER:
 MATERIAL None
 FINISH None

	NAME	DATE
DRAWN	JRK	9/23/16
CHECKED	JRK	9/23/16
ENG APPR.		
MFG APPR.		
Q.A.		
COMMENTS:		



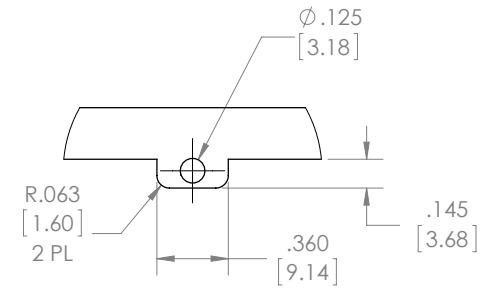
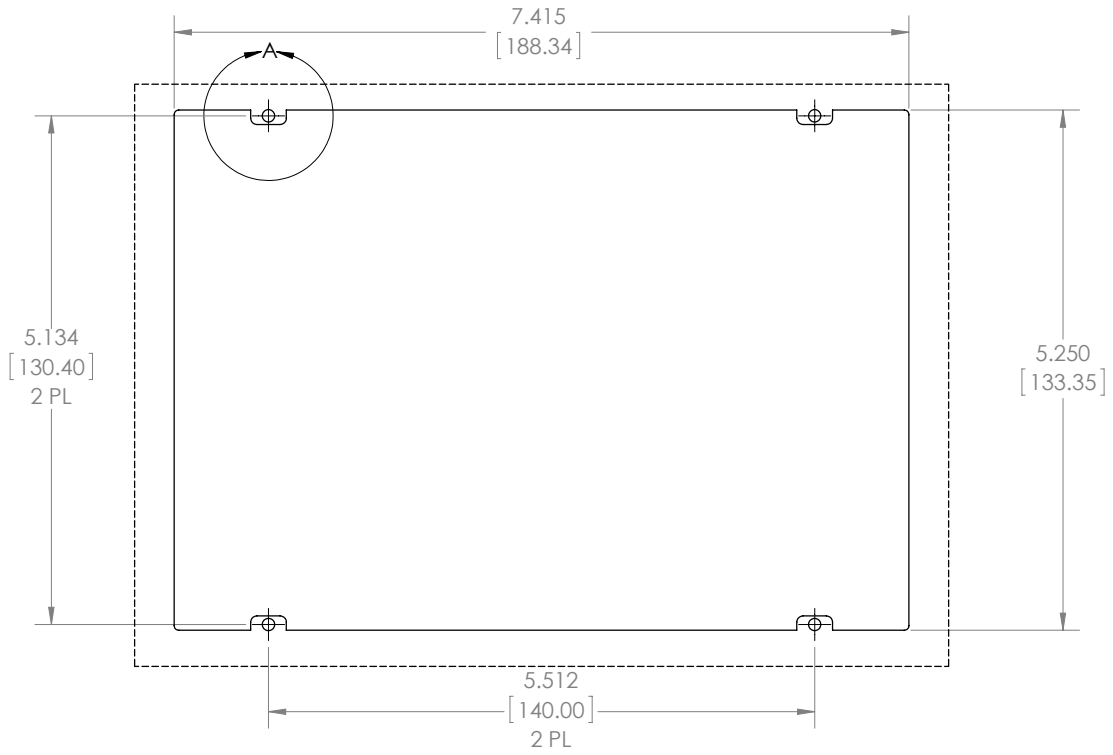
TITLE:
**TS-TPC-7990,
 Mounting & Clearance**

SIZE DWG. NO. A0.0
B 02-7595-5

SCALE: NONE SHEET 1 OF 1

8 7 6 5 4 3 2 1

REVISIONS				
ZONE	REV.	DESCRIPTION	DATE	APPROVED
	A0.0	Original Release	10/6/2017	JRK



DETAIL A
SCALE 6 : 4
4 PL

D
C
B
A

D
C
B
A

GENERAL NOTES:

- 1. All dimension in inches [millimeters]

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UNLESS OTHERWISE SPECIFIED:
DIMENSIONS ARE IN INCHES
TOLERANCES:
FRACTIONAL ± 1/64
ANGULAR: MACH ± .25° BEND ± 1°
x.xxx ± .005
x.xx ± .010
x.x ± .020
INTERPRET GEOMETRIC TOLERANCING PER:
MATERIAL
FINISH

NAME	DATE
DRAWN JRK	10/6/17
CHECKED	
ENG APPR.	
MFG APPR.	
Q.A.	
COMMENTS:	



TITLE: TS-7990 Mounting Cutout Pattern		
SIZE B	DWG. NO. 02-0008-9	A0.0
SCALE: NONE		SHEET 1 OF 1

8 7 6 5 4 3 2 1



16525 East Laser Drive Phone 480-837-5200
Fountain Hills, AZ 85268 Fax 480-837-5300

02/11/19

Subject: Certificate of Cooperation with RoHS 2

Dear Customer,

Technologic Systems Inc. is aware of the "Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (recast)" referred to as RoHS 2 and is making an effort to ensure that all of the components used in our products are compliant with this standard.

Technologic Systems affirms that the listed part number(s) below and all customized derivatives of these part numbers, are comprised solely of components which have shown compliance with Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 (RoHS 2)

TS-TPC-7990-QMW2E
TS-TPC-7990-QMW3E
TS-TPC-7990-SMN2E
TS-TPC-7990-SMN3E

Technologic Systems has access to reports showing that the components used in the above part do not contain any of the following except where covered by RoHS exemption 7c-I*:

- 1) Mercury (Hg)
- 2) Cadmium (Cd),
- 3) Hexavalent chromium (Cr (VI)),
- 4) Polybrominated biphenyls (PBB) and
- 5) Polybrominated diphenyl ethers (PBDE)
- 6) Lead (Pb)

The reports regarding the RoHS 2 status of each electrical component used in the above product can be provided within 45 days of a written request, if the requestor signs a BOM Sharing Agreement restricting the use of shared information to proving compliance to environmental standards.

A handwritten signature in black ink, appearing to read "Robert L. Miller", is written over a white background.

Robert L. Miller
President

***Exemption 7(c)-I:** Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.